

# 36V<sub>IN</sub>, 5A, 2-Quadrant CVCC Step-Down μModule Regulator

## FEATURES

- Complete Step-Down Switch Mode Power Supply
- CVCC: Constant-Voltage Constant-Current
- 2-Quadrant: Sources and Sinks Output Current
- Adjustable Output Current
- Wide Input Voltage Range: 6V to 36V
- 1.2V to 24V Output Voltage
- Forced Continuous Operation
- Selectable Switching Frequency: 100kHz to 1MHz
- (e4) RoHS Compliant Package with Gold Pad Finish
- Programmable Soft-Start
- Tiny, Low Profile (11.25mm × 15mm × 2.82mm) Surface Mount LGA Package

## APPLICATIONS

- Constant-Frequency Voltage Regulation Even at No Load
- Peltier Driver
- Battery Tester
- Battery/Supercap Charging and Cell Balancing
- Motor Drive Power Regulator
- High Power LED Drive

## DESCRIPTION

The LTM8052 is a 36V<sub>IN</sub>, 5A, 2-quadrant constant-voltage, constant-current (CVCC) step-down μModule® regulator. Included in the package are the switching controller, power switches, inductor and support components. Operating over an input voltage range of 6V to 36V, the LTM8052 supports an output voltage range of 1.2V to 24V. The LTM8052 is able to sink or source current to maintain voltage regulation up to the positive and negative current limits. This output current limit can be set by a control voltage, a single resistor or a thermistor.

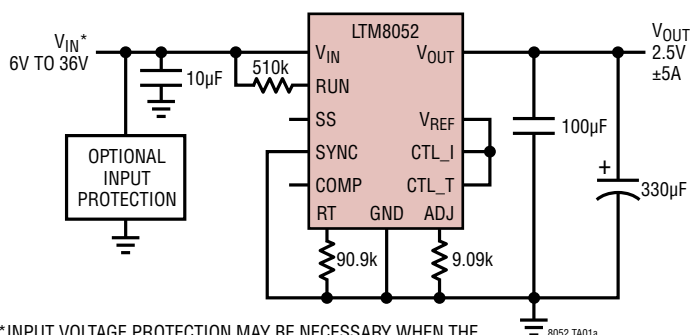
The LTM8052 is packaged in a thermally-enhanced, compact (11.25mm × 15mm × 2.82mm) RoHS compliant, overmolded land grid array (LGA) package suitable for automated assembly by standard surface mount equipment.

PART NUMBER	BEST FOR
LTM8052	Sinking and Sourcing Output Current
LTM8026	Sourcing more than 3A of output current. (Less than 3A maximum consider LTM8025.)

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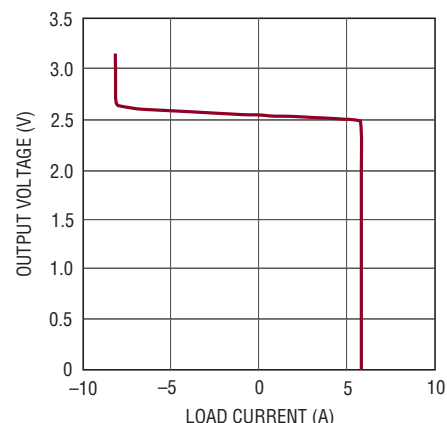
## TYPICAL APPLICATION

±5A, 2.5V (2-Quadrant) μModule Voltage Regulator



\*INPUT VOLTAGE PROTECTION MAY BE NECESSARY WHEN THE LTM8052 IS SINKING CURRENT (SEE APPLICATIONS INFORMATION)

Output Voltage vs Output Current



8052 TA01b

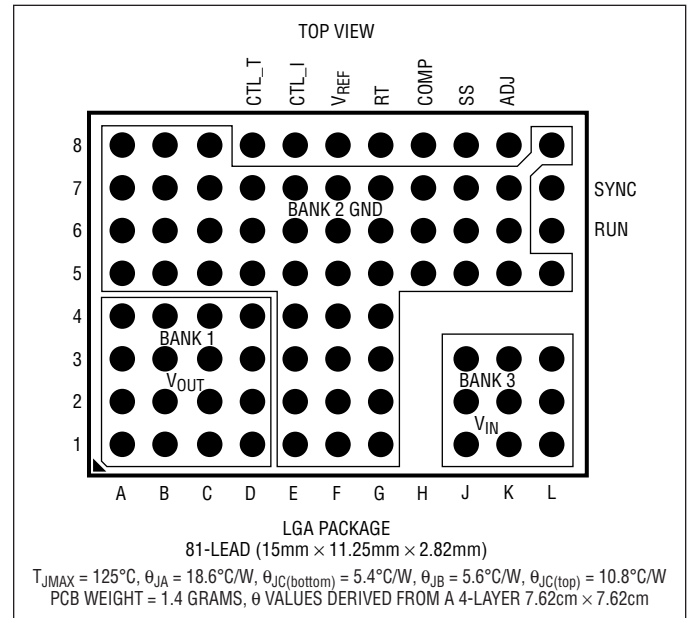
# LTM8052

## ABSOLUTE MAXIMUM RATINGS

(Note 1)

$V_{IN}$ .....	40V
ADJ, RT, COMP, CTL_I, CTL_T, $V_{REF}$ .....	3V
$V_{OUT}$ .....	25V
RUN, SYNC, SS .....	6V
Current Into RUN Pin .....	100 $\mu$ A
Internal Operating Temperature Range ..	–40°C to 125°C
Solder Temperature .....	250°C
Storage Temperature .....	–55°C to 125°C

## PIN CONFIGURATION



## ORDER INFORMATION

LEAD FREE FINISH	TRAY	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE†
LTM8052EV#PBF	LTM8052EV#PBF	LTM8052V	81-Lead (15mm × 11.25mm × 2.82mm) LGA	–40°C to 125°C
LTM8052IV#PBF	LTM8052IV#PBF	LTM8052V	81-Lead (15mm × 11.25mm × 2.82mm) LGA	–40°C to 125°C

Consult LTC Marketing for parts specified with wider operating temperature ranges. \*The temperature grade is identified by a label on the shipping container.

For more information on lead free part marking, go to: <http://www.linear.com/leadfree/>

This product is only offered in trays. For more information go to: <http://www.linear.com/packaging/>

† Refer to Note 3

## ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full internal operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . RUN = 3V, unless otherwise noted. (Note 3)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Minimum Input Voltage	●			6	V
Output DC Voltage	$I_{OUT} = 1\text{A}$ , $R_{ADJ}$ Open		1.2		V
	$I_{OUT} = 1\text{A}$ , $R_{ADJ} = 499\Omega$		24		V
Output DC Current	CTL_T, CTL_I = 1.5V	–6		5	A
Quiescent Current Into $V_{IN}$	$V_{IN} = 12\text{V}$ , RUN = 0V		0.1	3	$\mu\text{A}$
	$V_{IN} = 12\text{V}$ , No Load		17	30	mA
Line Regulation	$6\text{V} < V_{IN} < 36\text{V}$ , $I_{OUT} = 1\text{A}$		0.1		%
Load Regulation	$V_{IN} = 12\text{V}$ , $0\text{A} < I_{OUT} < 5\text{A}$		0.7		%
Output RMS Voltage Ripple	$V_{IN} = 12\text{V}$ , $I_{OUT} = 4.5\text{A}$		10		mV
Switching Frequency	$R_T = 40.2\text{k}$ $R_T = 453\text{k}$		1000 100		kHz kHz
Voltage at ADJ Pin	●	1.16	1.19	1.22	V
Current Out of ADJ Pin	ADJ = 0V, $V_{OUT} = 1\text{V}$		100		$\mu\text{A}$
RUN Pin Current	RUN = 1.45V		5.5		$\mu\text{A}$

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## ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full internal operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .  $V_{IN} = 3\text{V}$ , unless otherwise noted. (Note 3)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
RUN Threshold Voltage (Falling)		1.49	1.55	1.61	V
RUN Input Hysteresis			160		mV
CTL_I Control Range		0		1.5	V
CTL_I Pin Current				1.5	$\mu\text{A}$
CTL_I Positive Current Limit	CTL_I = 1.5V	5.1	5.6	6.1	A
	CTL_I = 0.75V	2.24	2.8	3.36	A
CTL_I Negative Current Limit	CTL_I = 1.5V	-8.5	-7.7	-6.9	A
	CTL_I = 0.75V	-5.7	-5.1	-4.5	A
CTL_T Control Range		0		1.5	V
CTL_T Pin Current				1.5	$\mu\text{A}$
CTL_T Positive Current Limit	CTL_T = 1.5V	5.1	5.6	6.1	A
	CTL_T = 0.75V	2.24	2.8	3.36	A
CTL_T Negative Current Limit	CTL_T = 1.5V	-8.5	-7.7	-6.9	A
	CTL_T = 0.75V	-5.5	-4.9	-4.3	A
$V_{REF}$ Voltage	0.5mA Load	1.93	2	2.04	V
SS Pin Current			11		$\mu\text{A}$
SYNC Input Low Threshold	$f_{SYNC} = 400\text{kHz}$			0.6	V
SYNC Input High Threshold	$f_{SYNC} = 400\text{kHz}$	1.2			V
SYNC Bias Current	SYNC = 0V			1	$\mu\text{A}$

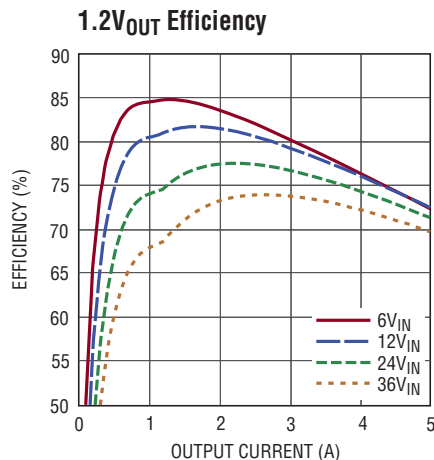
**Note 1:** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

**Note 2:** This  $\mu\text{Module}$  regulator includes overtemperature protection that is intended to protect the device during momentary overload conditions. Internal temperature will exceed  $125^\circ\text{C}$  when overtemperature protection is active. Continuous operation above the specified maximum internal operating junction temperature may impair device reliability.

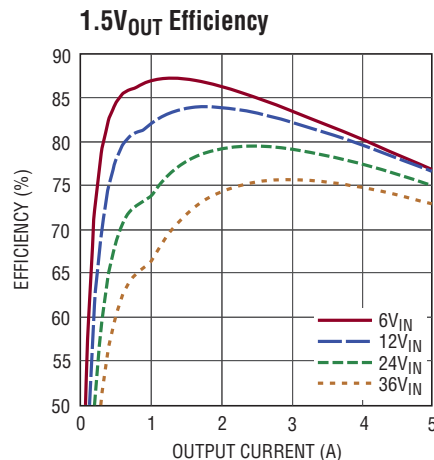
**Note 3:** The LTM8052E is guaranteed to meet performance specifications from  $0^\circ\text{C}$  to  $125^\circ\text{C}$  internal operating temperature. Specifications over the full  $-40^\circ\text{C}$  to  $125^\circ\text{C}$  internal operating temperature range are assured by design, characterization and correlation with statistical process controls. The LTM8052I is guaranteed to meet specifications over the full  $-40^\circ\text{C}$  to  $125^\circ\text{C}$  internal operating temperature range. Note that the maximum internal temperature is determined by specific operating conditions in conjunction with board layout, the rated package thermal resistance and other environmental factors.

## TYPICAL PERFORMANCE CHARACTERISTICS

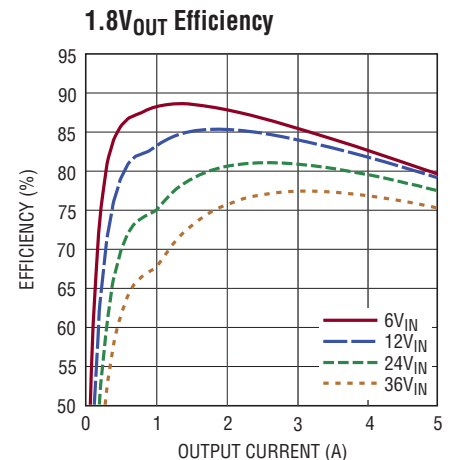
$T_A = 25^\circ\text{C}$ , unless otherwise noted.



8052 G01



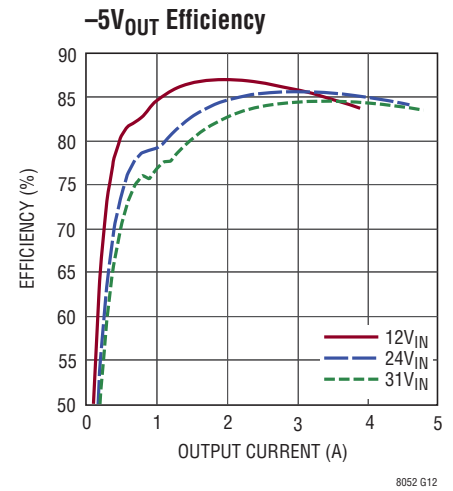
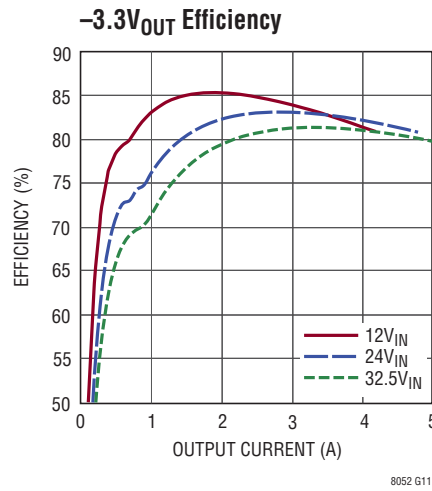
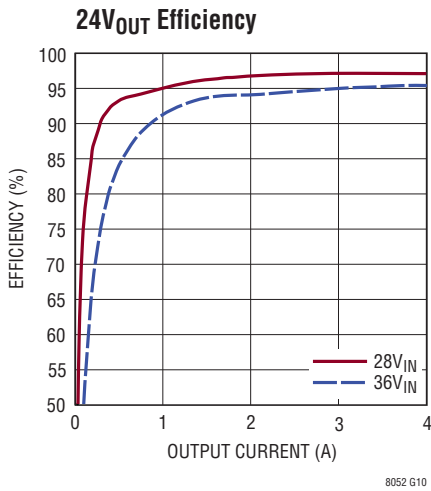
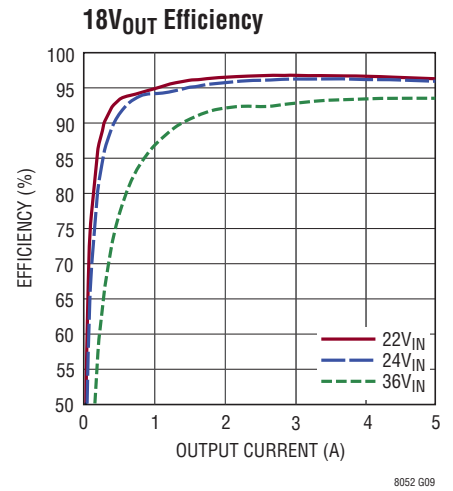
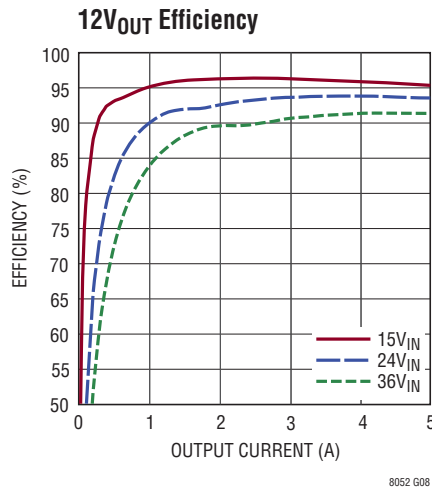
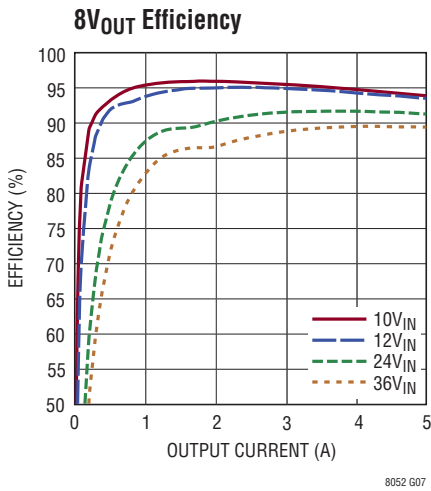
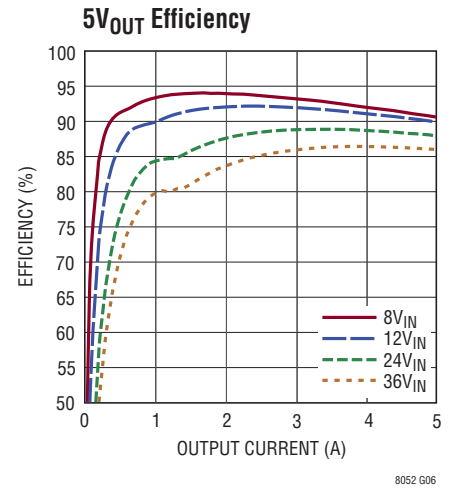
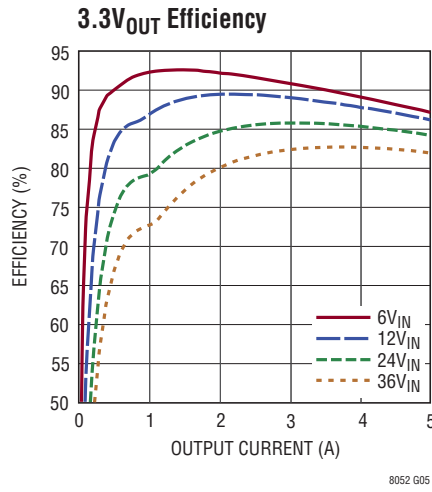
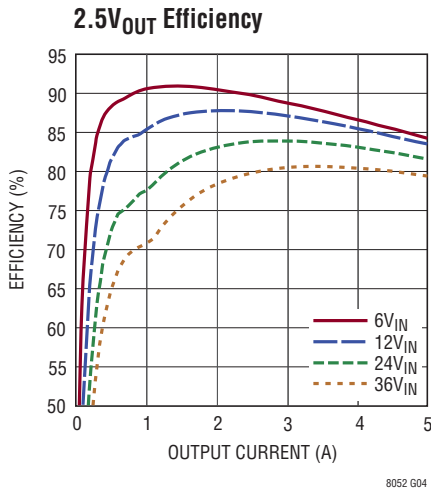
8052 G02



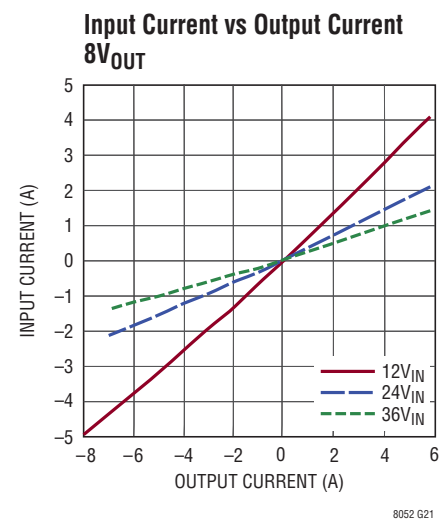
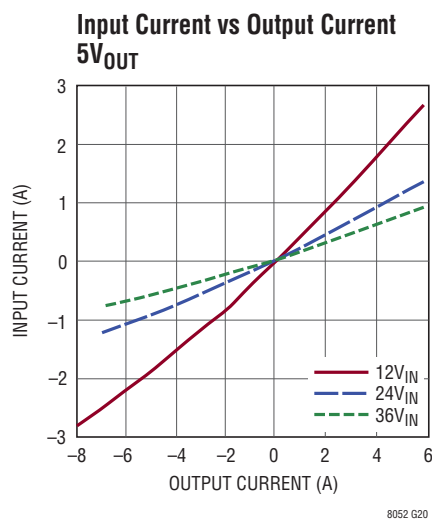
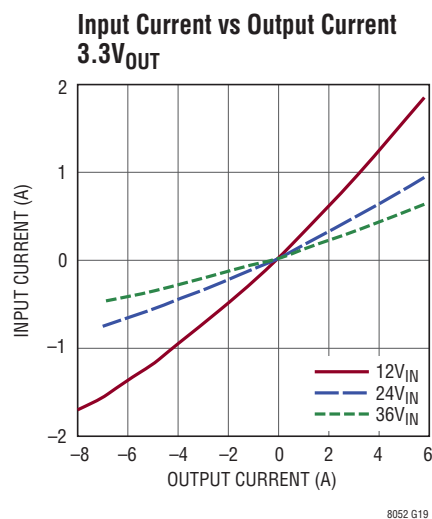
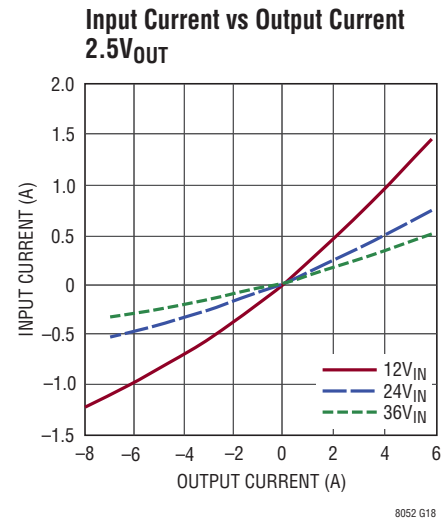
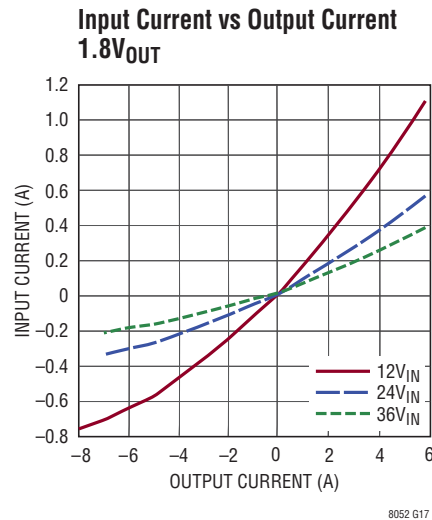
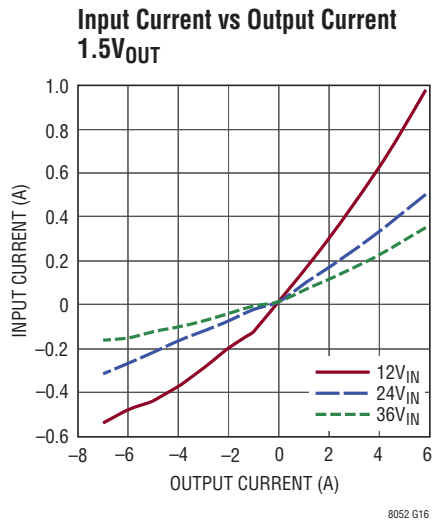
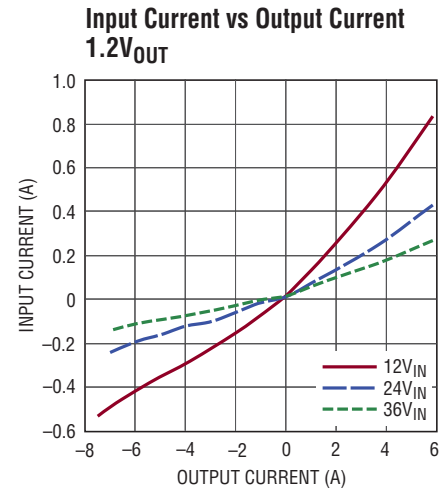
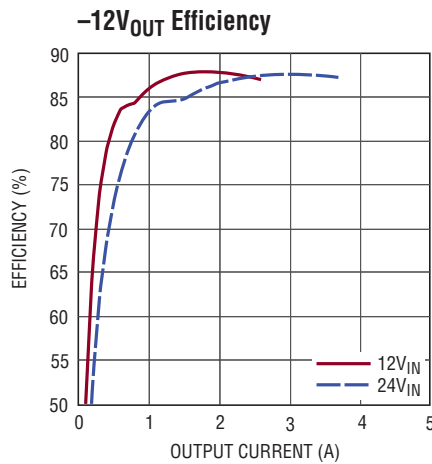
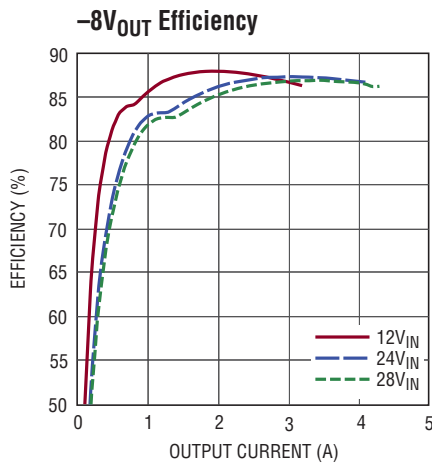
8052 G03

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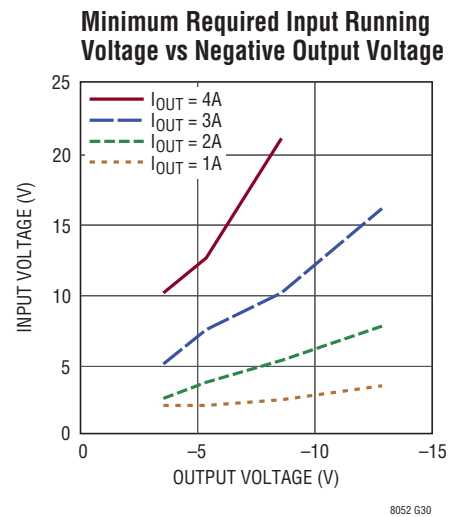
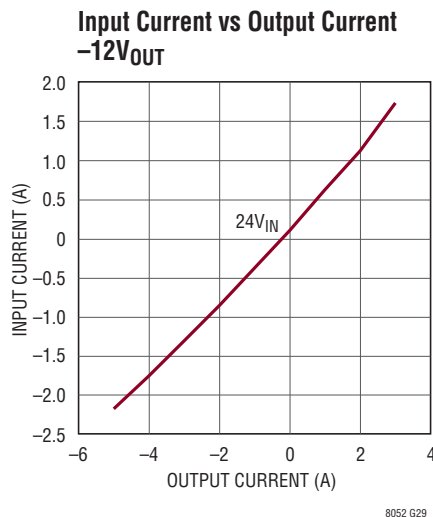
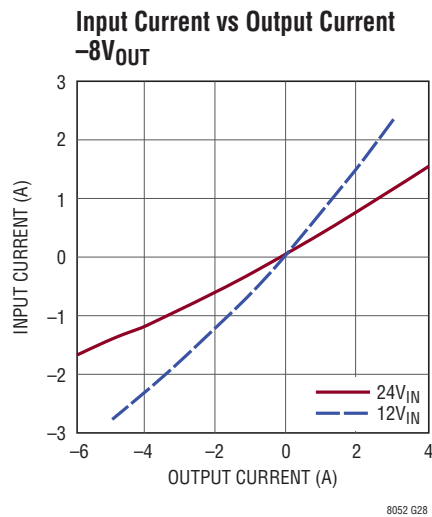
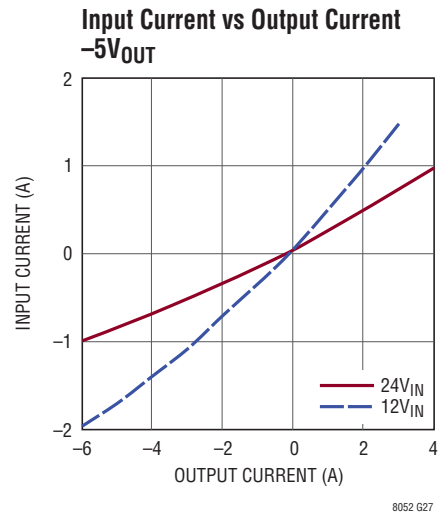
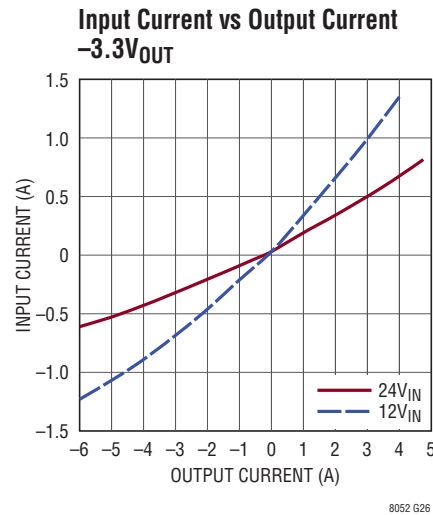
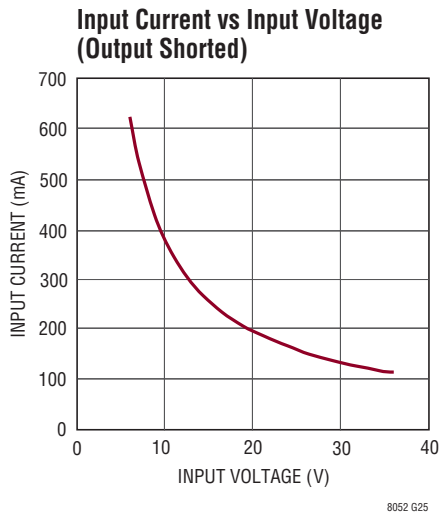
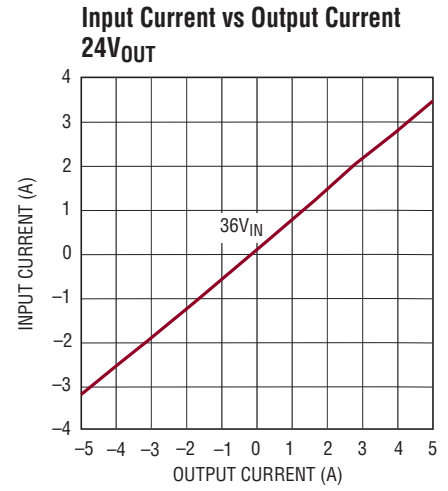
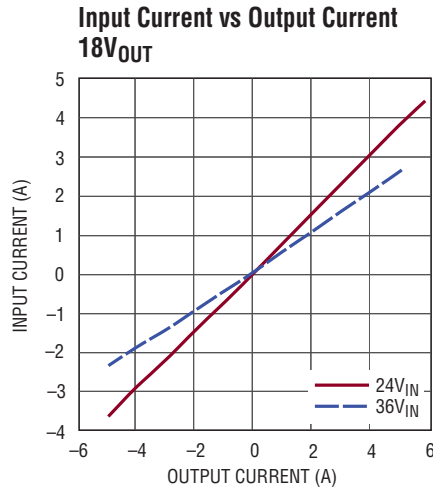
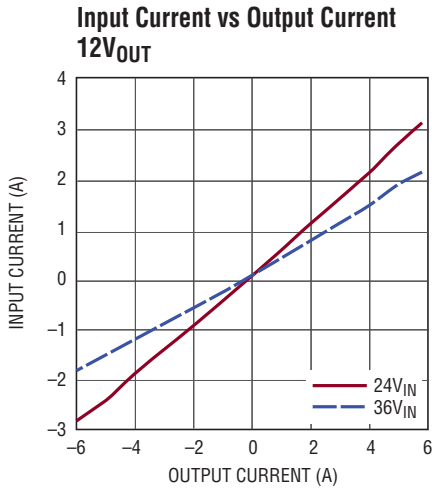
# TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$ , unless otherwise noted.



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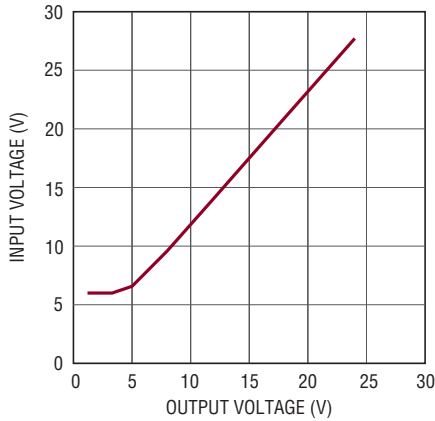


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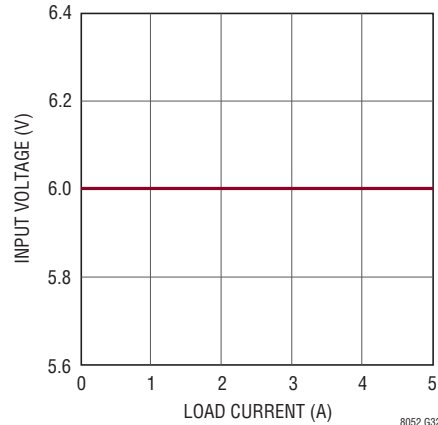
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**Minimum Required Input Running Voltage vs Output Voltage,  $I_{OUT} = 5\text{A}$**



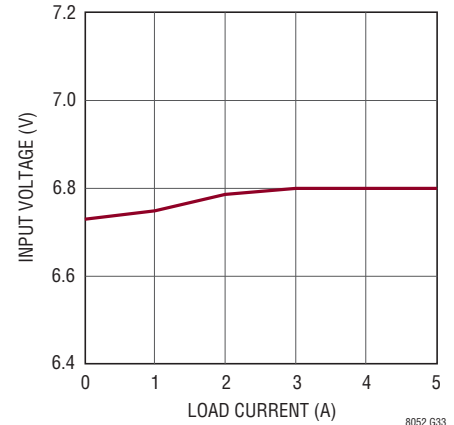
8052 G31

**Minimum Required Input Voltage vs Load  $3.3V_{OUT}$  and Below**



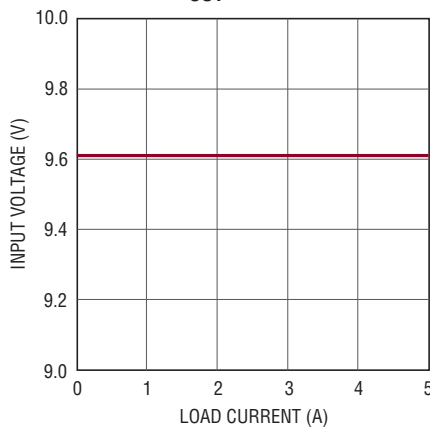
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**Minimum Required Input Voltage vs Load  $5V_{OUT}$**



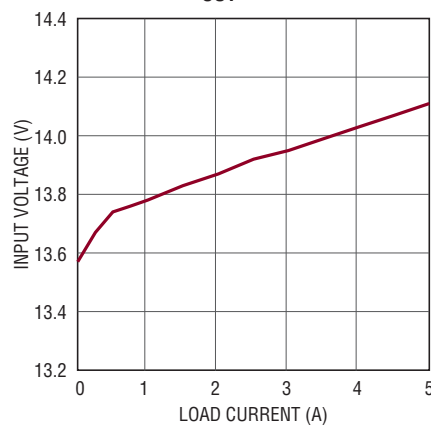
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**Minimum Required Input Voltage vs Load  $8V_{OUT}$**



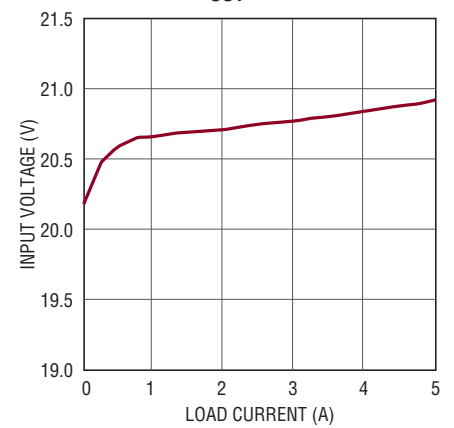
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**Minimum Required Input Voltage vs Load  $12V_{OUT}$**



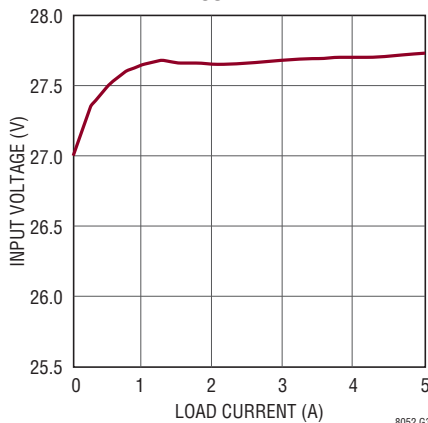
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**Minimum Required Input Voltage vs Load  $18V_{OUT}$**



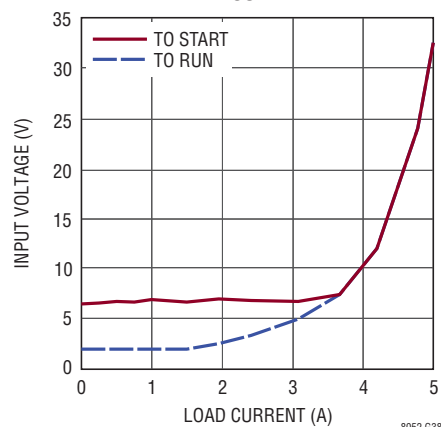
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**Minimum Required Input Voltage vs Load  $24V_{OUT}$**



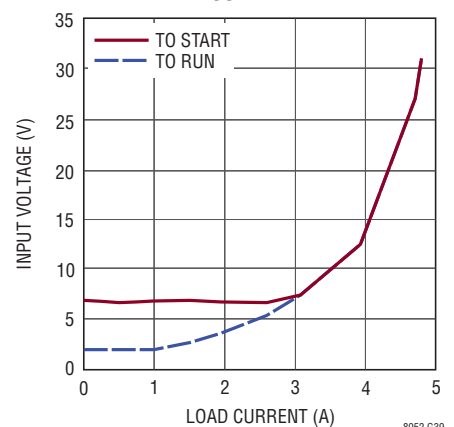
8052 G3

**Minimum Required Input Voltage vs Load  $-3.3V_{OUT}$**



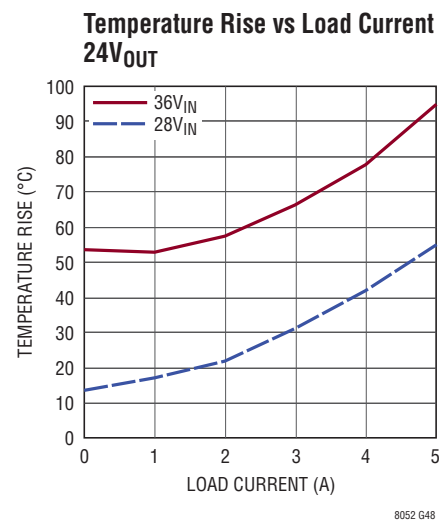
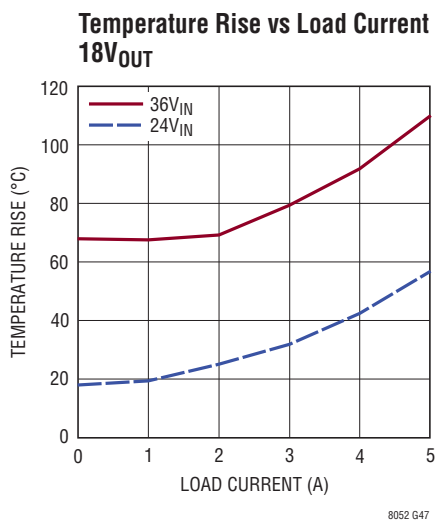
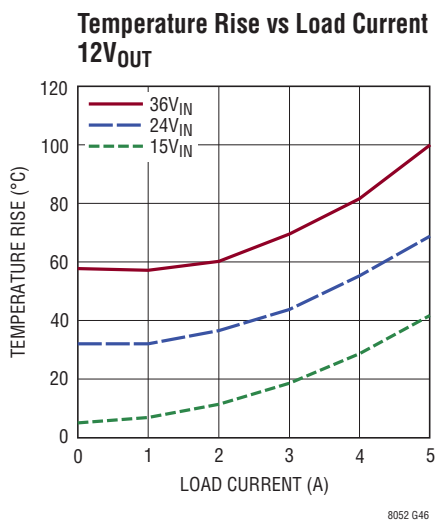
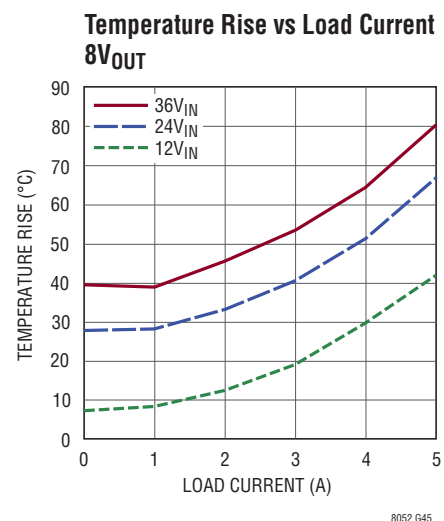
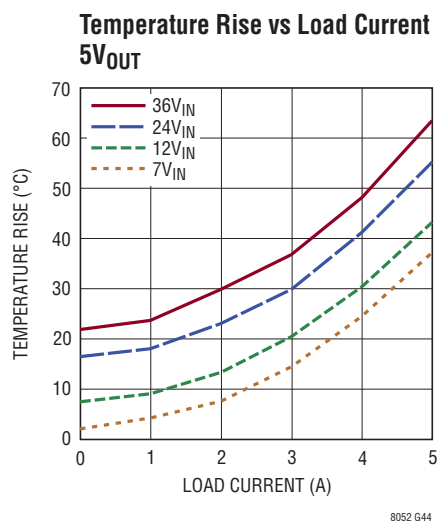
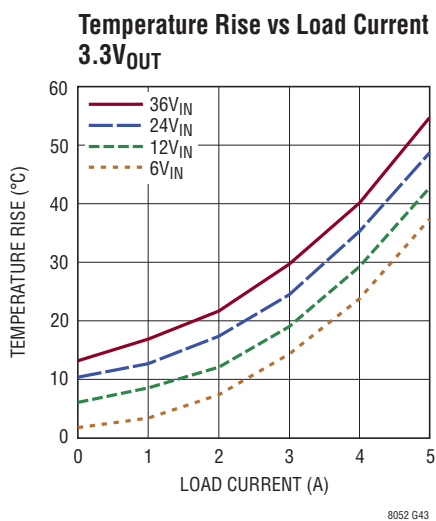
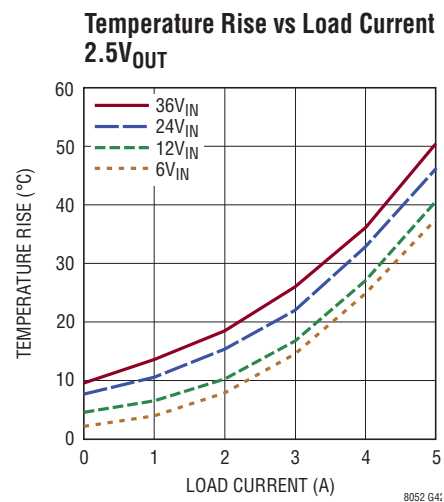
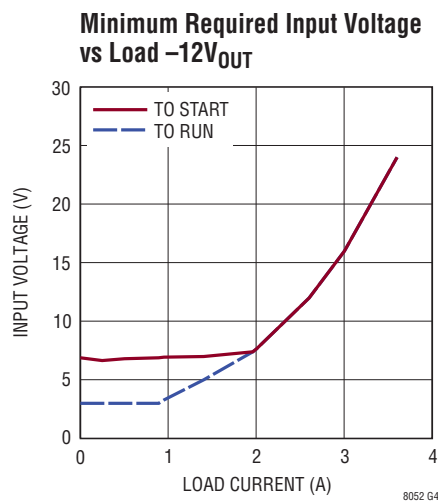
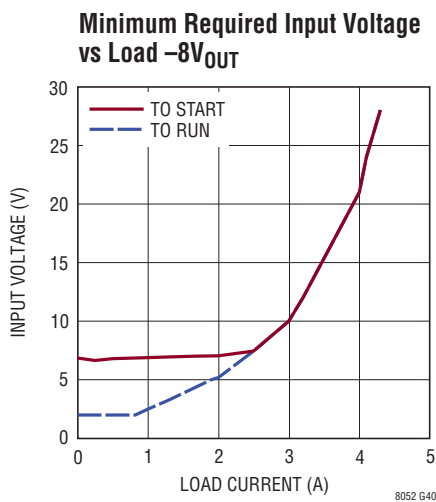
8052 G38

**Minimum Required Input Voltage vs Load  $-5V_{OUT}$**



8052 G39

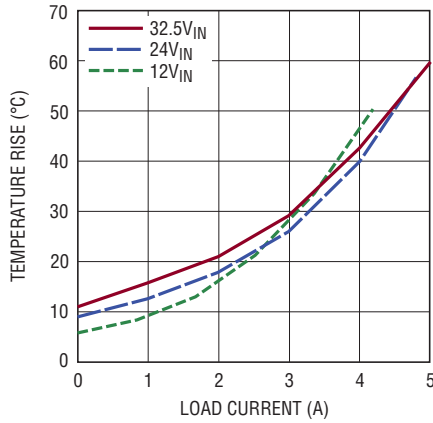
TYPICAL PERFORMANCE CHARACTERISTICS  $T_A = 25^{\circ}\text{C}$ , unless otherwise noted.





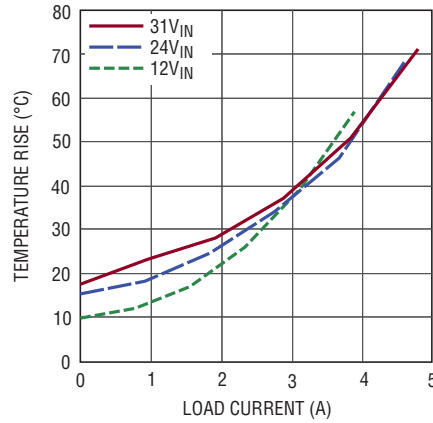
# TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$ , unless otherwise noted.

Temperature Rise vs Load Current  
-3.3V<sub>OUT</sub>



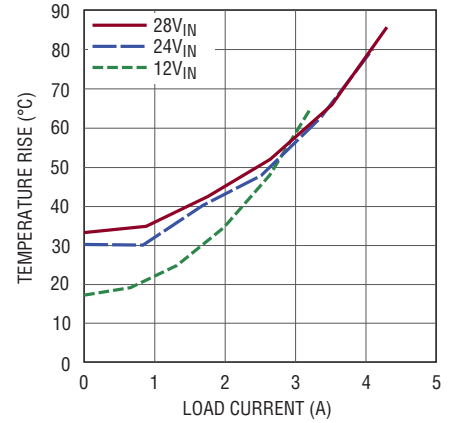
8052 G49

Temperature Rise vs Load Current  
-5V<sub>OUT</sub>



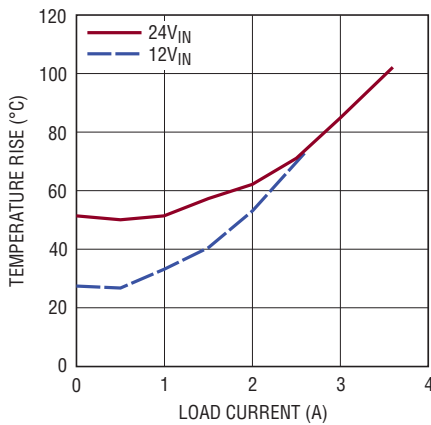
8052 G50

Temperature Rise vs Load Current  
-8V<sub>OUT</sub>



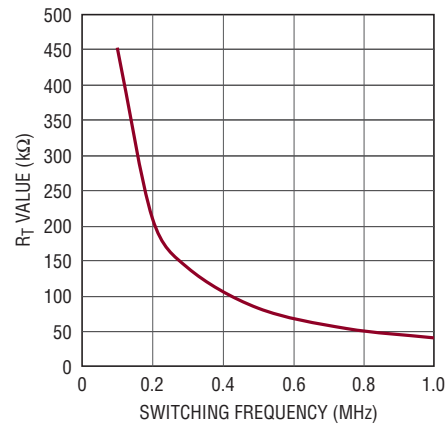
8052 G51

Temperature Rise vs Load Current  
-12V<sub>OUT</sub>



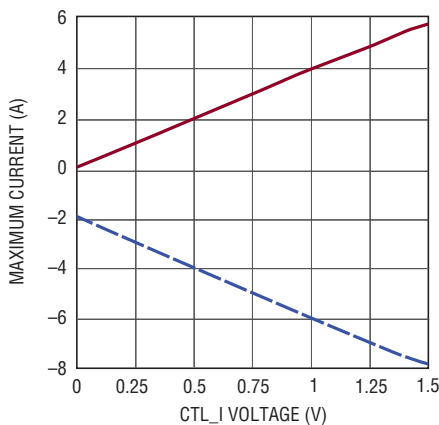
8052 G52

Switching Frequency vs R<sub>T</sub> Value



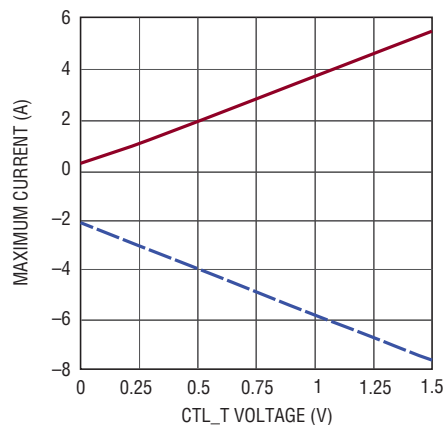
8052 G53

CTL\_I Voltage vs Maximum  
Output Current, CTL\_T = 2V



8052 G54

CTL\_T Voltage vs Maximum  
Output Current, CTL\_I = 2V



8052 G55

## PIN FUNCTIONS

**V<sub>OUT</sub> (Bank 1):** Power Output Pins. Apply the output filter capacitor and the output load between these pins and GND pins. When reverse current is being driven into the LTM8052's output by the load, the energy is delivered back through the LTM8052 and out to the V<sub>IN</sub> pins. Care must be taken to prevent excessive voltage if other devices on the V<sub>IN</sub> bus cannot absorb this energy. See Input Precautions in the Applications Information section for more details and circuit suggestions.

**GND (Bank 2):** Tie these GND pins to a local ground plane below the LTM8052 and the circuit components. In most applications, the bulk of the heat flow out of the LTM8052 is through these pads, so the printed circuit design has a large impact on the thermal performance of the part. See the PCB Layout and Thermal Considerations sections for more details. Return the feedback divider (R<sub>ADJ</sub>) to this net.

**V<sub>IN</sub> (Bank 3):** The V<sub>IN</sub> pins supply current to the LTM8052's internal regulator and to the internal power switches. This pin must be locally bypassed with an external, low ESR capacitor; see Table 1 for recommended values.

**CTL\_T (Pin D8):** Connect a resistor/NTC thermistor network to the CTL\_T pin to reduce the maximum regulated output current of the LTM8052 in response to temperature. The maximum control voltage is 1.5V. If this function is not used, tie this pin to V<sub>REF</sub>.

**CTL\_I (Pin E8):** The CTL\_I pin reduces the maximum regulated output current of the LTM8052. The maximum control voltage is 1.5V. If this function is not used, tie this pin to V<sub>REF</sub>.

**V<sub>REF</sub> (Pin F8):** Buffered 2V Reference Capable of 0.5mA Drive. It is valid when V<sub>IN</sub> > 6V and RUN is active high.

**RT (Pin G8):** The RT pin is used to program the switching frequency of the LTM8052 by connecting a resistor from this pin to ground. The Applications Information section of the data sheet includes a table to determine the resistance value based on the desired switching frequency. When using the SYNC function, apply a resistor value equivalent to 20% lower than the clock frequency applied to the SYNC pin. Do not leave this pin open.

**COMP (Pin H8):** Compensation Pin. This pin is generally not used. The LTM8052 is internally compensated, but some rare situations may arise that require a modification to the control loop. This pin connects directly to the input PWM comparator of the LTM8052. In most cases, no adjustment is necessary. If this function is not used, leave this pin open.

**SS (Pin J8):** Soft-Start Pin. Place an external capacitor to ground to ramp the output voltage during start-up conditions. The soft-start pin has an 11μA charging current.

**ADJ (Pin K8):** The LTM8052 regulates its ADJ pin to 1.19V. Connect the adjust resistor from this pin to ground. The value of R<sub>ADJ</sub> is given by the equation:

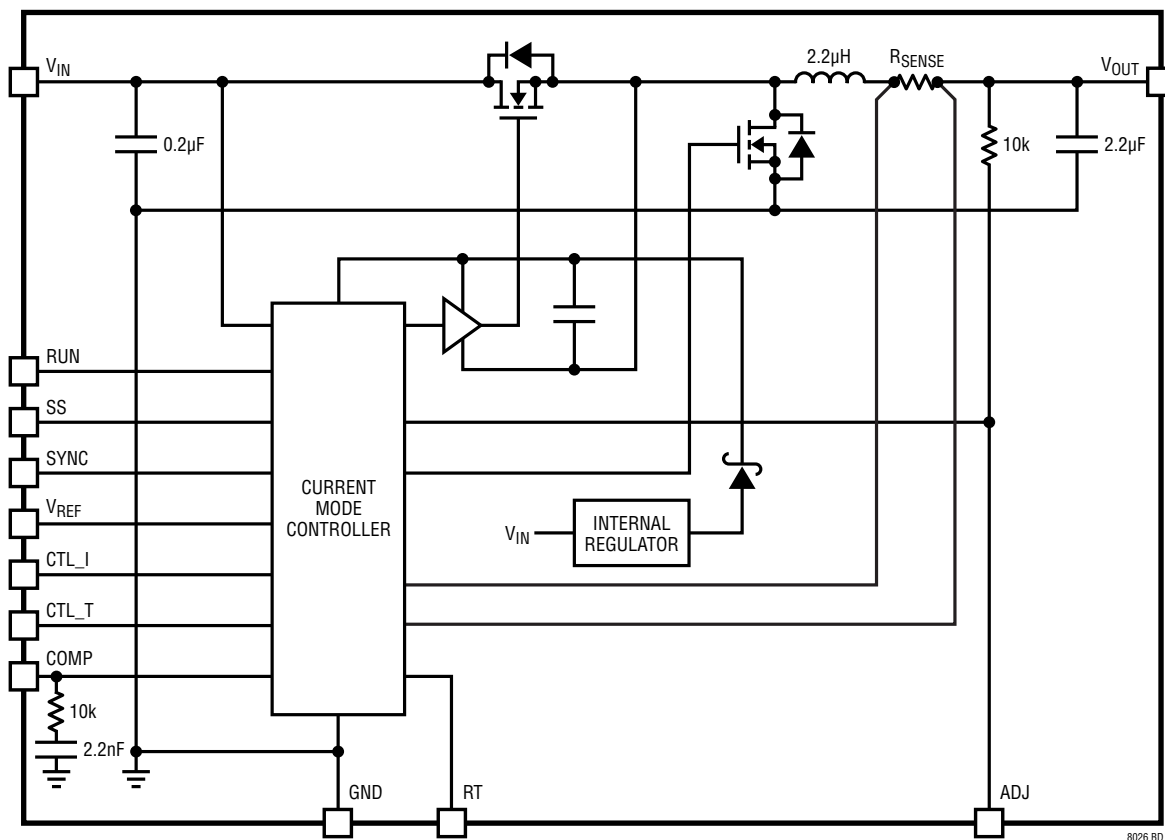
$$R_{ADJ} = \frac{11.9}{V_{OUT} - 1.19}$$

where R<sub>ADJ</sub> is in kΩ.

**RUN (Pin L6):** The RUN pin acts as an enable pin and turns on the internal circuitry. It may also be used to implement a precision UVLO. See the Applications Information section for details. The RUN pin is internally clamped, so it may be pulled up to a voltage source that is higher than the absolute maximum voltage of 6V through a resistor, provided the pin current does not exceed 100μA. Do not leave this pin open.

**SYNC (Pin L7):** Frequency Synchronization Pin. This pin allows the switching frequency to be synchronized to an external clock. The R<sub>T</sub> resistor should be chosen to operate the internal clock at 20% lower than the SYNC pulse frequency. This pin should be grounded when not in use. Do not leave this pin floating. When laying out the board, avoid noise coupling to or from the SYNC trace. See the Synchronization section in Applications Information.

## BLOCK DIAGRAM



## OPERATION

The LTM8052 is a standalone nonisolated constant-voltage, constant-current step-down switching DC/DC power supply that can deliver up to 5A of positive or 6A of negative output current. This  $\mu$ Module regulator provides a precisely regulated output voltage programmable via one external resistor from 1.2V to 24V. The input voltage range is 6V to 36V. Given that the LTM8052 is a step-down converter, make sure that the input voltage is high enough to support the desired output voltage and load current.

The LTM8052 is a 2-quadrant device, meaning that it can both source and sink current in order to regulate its output voltage. Most traditional voltage regulators are one quadrant; that is, they only source current. If the load, for whatever reason, forces current into a traditional regulator, the output voltage will typically rise. In a similar situation,

the LTM8052 will sink current to keep the output voltage in regulation.

It should be clear that the above situation is only possible if the load is providing energy to the LTM8052 output. The LTM8052 will be able to maintain the output voltage at the target regulation point as long as the current from the load does not exceed its negative current limit. If the current does exceed the negative current limit, the LTM8052 output will start to rise. If the output continues to rise, the LTM8052's output overvoltage protection circuitry will turn off the internal power switches, and the output will be free to rise. If this voltage rises above the LTM8052 input voltage, current will flow through an internal diode, and the output will be clamped to a diode drop above the input.

## OPERATION

When the LTM8052 is sinking current, it maintains its output voltage regulation by power conversion, not power dissipation. This means that the energy provided to the LTM8052 is in turn delivered to its input power bus. There must be something on this power bus to accept or use the energy, or the LTM8052's input voltage will rise. Left unchecked, the energy can raise the input voltage above the absolute maximum voltage and damage the LTM8052. Please see the Input Precautions section for further details. For applications where only sourcing current (one quadrant operation) is desired, use LTM8026.

The LTM8052 operates in forced continuous mode. This means that the part will not skip cycles when the load approaches zero amps. This may be particularly useful in applications where the synchronization function is used, or any time discontinuous switching is undesirable. The LTM8052 will not operate in forced continuous mode when an input UVLO, output OVLO or minimum duty cycle violation occurs.

As shown in the Block Diagram, the LTM8052 contains a current mode controller, power switches, power inductor, and a modest amount of input and output capacitance.

The LTM8052 utilizes fixed frequency, average current mode control to accurately regulate the inductor current, independent from the output voltage. This is an ideal solution for applications requiring a regulated current source. The control loop will regulate the current in the internal inductor. Once the output has reached the regulation voltage determined by the resistor from the ADJ pin to ground, the inductor current will be reduced by the voltage regulation loop.

The output current loop has two control inputs, determined by the voltage at the analog control pins, CTL\_I and CTL\_T. CTL\_I is typically used to set the maximum allowable current output of the LTM8052, while CTL\_T is typically used with a NTC thermistor to reduce the output current in response to temperature. The lower of the two analog voltages on CTL\_I and CTL\_T determines the regulated output current. The analog control range of both the CTL\_I and CTL\_T pin is from 0V to 1.5V. As shown in the Typical Performance Characteristics section, the positive and negative currents are not symmetric. The negative current limit is offset by approximately 2A.

The RUN pin functions as a precision shutdown pin. When the voltage at the RUN pin is lower than 1.55V, switching is terminated. Below the turn-on threshold, the RUN pin sinks 5.5 $\mu$ A. This current can be used with a resistor between RUN and  $V_{IN}$  to set a hysteresis. During start-up, the SS pin is held low until the part is enabled, after which the capacitor at the soft-start pin is charged with an 11 $\mu$ A current source.

The LTM8052 is equipped with a thermal shutdown to protect the device during momentary overload conditions. It is set above the 125°C absolute maximum internal temperature rating to avoid interfering with normal specified operation, so internal device temperatures will exceed the absolute maximum rating when the overtemperature protection is active. So, continuous or repeated activation of the thermal shutdown may impair device reliability. During thermal shutdown, all switching is terminated and the SS pin is driven low.

The switching frequency is determined by a resistor at the RT pin. The LTM8052 may also be synchronized to an external clock through the use of the SYNC pin.

## APPLICATIONS INFORMATION

For most applications, the design process is straight forward, summarized as follows:

1. Look at Table 1 and find the row that has the desired input range and output voltage.
2. Apply the recommended  $C_{IN}$ ,  $C_{OUT}$ ,  $R_{ADJ}$  and  $R_T$  values.

While these component combinations have been tested for proper operation, it is incumbent upon the user to verify proper operation over the intended system's line, load and environmental conditions. Bear in mind that the maximum output current is limited by junction temperature, the relationship between the input and output voltage magnitude and polarity and other factors. Please refer to the

**Table 1. Recommended Component Values and Configuration.**  
( $T_A = 25^\circ\text{C}$ . See Typical Performance Characteristics for Load Conditions)

$V_{IN}$	$V_{OUT}$	$C_{IN}$	$C_{OUT}$ CERAMIC	$C_{OUT}$ ELECTROLYTIC	$R_{ADJ}$	$f_{OPTIMAL}$	$R_T(OPTIMAL)$	$f_{MAX}$	$R_T(MIN)$
6V to 36V	1.2	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	470 $\mu$ F, 6.3V, 9m $\Omega$ , Chemi-Con, APXF6R3ARA471MH80G	Open	200kHz	210k	250kHz	169k
6V to 36V	1.5	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	470 $\mu$ F, 6.3V, 9m $\Omega$ , Chemi-Con, APXF6R3ARA471MH80G	38.3k	300kHz	140k	350kHz	118k
6V to 36V	1.8	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	470 $\mu$ F, 6.3V, 9m $\Omega$ , Chemi-Con, APXF6R3ARA471MH80G	19.6k	350kHz	118k	400kHz	102k
6V to 36V	2.5	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	330 $\mu$ F, 4V, 27m $\Omega$ , OS-CON, 4SVPC330M	9.09k	450kHz	90.9k	525kHz	78.7k
6V to 36V	3.3	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	330 $\mu$ F, 4V, 27m $\Omega$ , OS-CON, 4SVPC330M	5.62k	550kHz	75.0k	625kHz	64.9k
7V to 36V	5	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	120 $\mu$ F, 16V, 27m $\Omega$ , OS-CON, 16SVPC120M	3.09k	600kHz	68.1k	700kHz	57.6k
10V to 36V	8	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 10V, 1210	120 $\mu$ F, 16V, 27m $\Omega$ , OS-CON, 16SVPC120M	1.74k	625kHz	64.9k	750kHz	53.6k
15V to 36V	12	10 $\mu$ F, 50V, 1210	47 $\mu$ F, 16V, 1210	120 $\mu$ F, 16V, 27m $\Omega$ , OS-CON, 16SVPC120M	1.10k	650kHz	61.9k	800kHz	49.9k
22V to 36V	18	10 $\mu$ F, 50V, 1210	22 $\mu$ F, 25V, 1210	47 $\mu$ F, 20V, 45m $\Omega$ , OS-CON, 20SVPS47M	604	675kHz	59.0k	900kHz	44.2k
28V to 36V	24	4.7 $\mu$ F, 50V, 1210	10 $\mu$ F, 50V, 1206	47 $\mu$ F, 35V, 30m $\Omega$ , OS-CON, 35SVPC47M	523	700kHz	57.6k	1MHz	39.2k
9V to 15V	1.2	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	470 $\mu$ F, 6.3V, 9m $\Omega$ , Chemi-Con, APXF6R3ARA471MH80G	Open	200kHz	210k	525kHz	78.7k
9V to 15V	1.5	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	470 $\mu$ F, 6.3V, 9m $\Omega$ , Chemi-Con, APXF6R3ARA471MH80G	38.3k	300kHz	140k	650kHz	61.9k
9V to 15V	1.8	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	470 $\mu$ F, 6.3V, 9m $\Omega$ , Chemi-Con, APXF6R3ARA471MH80G	19.6k	350kHz	118k	800kHz	49.9k
9V to 15V	2.5	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	330 $\mu$ F, 4V, 27m $\Omega$ , OS-CON, 4SVPC330M	9.09k	450kHz	90.9k	1MHz	39.2k
9V to 15V	3.3	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	330 $\mu$ F, 4V, 27m $\Omega$ , OS-CON, 4SVPC330M	5.62k	550kHz	75.0k	1MHz	39.2k
9V to 15V	5	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	120 $\mu$ F, 16V, 27m $\Omega$ , OS-CON, 16SVPC120M	3.09k	600kHz	68.1k	1MHz	39.2k
10V to 15V	8	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 10V, 1210	120 $\mu$ F, 16V, 27m $\Omega$ , OS-CON, 16SVPC120M	1.74k	625kHz	64.9k	1MHz	39.2k
18V to 36V	1.2	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	470 $\mu$ F, 6.3V, 9m $\Omega$ , Chemi-Con, APXF6R3ARA471MH80G	Open	200kHz	210k	250kHz	169k
18V to 36V	1.5	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	470 $\mu$ F, 6.3V, 9m $\Omega$ , Chemi-Con, APXF6R3ARA471MH80G	38.3k	300kHz	140k	350kHz	118k
18V to 36V	1.8	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	470 $\mu$ F, 6.3V, 9m $\Omega$ , Chemi-Con, APXF6R3ARA471MH80G	19.6k	350kHz	118k	400kHz	102k
18V to 36V	2.5	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	330 $\mu$ F, 4V, 27m $\Omega$ , OS-CON, 4SVPC330M	9.09k	450kHz	90.9k	525kHz	78.7k
18V to 36V	3.3	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	330 $\mu$ F, 4V, 27m $\Omega$ , OS-CON, 4SVPC330M	5.62k	550kHz	75.0k	625kHz	64.9k
18V to 36V	5	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	120 $\mu$ F, 16V, 27m $\Omega$ , OS-CON, 16SVPC120M	3.09k	600kHz	68.1k	700kHz	57.6k
18V to 36V	8	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 10V, 1210	120 $\mu$ F, 16V, 27m $\Omega$ , OS-CON, 16SVPC120M	1.74k	625kHz	64.9k	750kHz	53.6k
18V to 36V	12	10 $\mu$ F, 50V, 1210	47 $\mu$ F, 16V, 1210	120 $\mu$ F, 16V, 27m $\Omega$ , OS-CON, 16SVPC120M	1.10k	650kHz	61.9k	800kHz	49.9k
2.7V to 32.5V*	-3.3	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	330 $\mu$ F, 4V, 27m $\Omega$ , OS-CON, 4SVPC330M	5.62k	550kHz	75.0k	625kHz	64.9k
2V to 31V*	-5	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 6.3V, 1210	120 $\mu$ F, 16V, 27m $\Omega$ , OS-CON, 16SVPC120M	3.09k	600kHz	68.1k	700kHz	57.6k
2V to 28V*	-8	10 $\mu$ F, 50V, 1210	100 $\mu$ F, 10V, 1210	120 $\mu$ F, 16V, 27m $\Omega$ , OS-CON, 16SVPC120M	1.74k	625kHz	64.9k	750kHz	53.6k
3V to 24V*	-12	10 $\mu$ F, 50V, 1210	47 $\mu$ F, 16V, 1210	120 $\mu$ F, 16V, 27m $\Omega$ , OS-CON, 16SVPC120M	1.10k	650kHz	61.9k	800kHz	49.9k

\*Running voltage. See the Typical Performance Characteristics section for starting requirements.

Note: An input bulk capacitor is required.

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graphs in the Typical Performance Characteristics section for guidance.

The maximum frequency (and attendant  $R_T$  value) at which the LTM8052 should be allowed to switch is given in Table 1 in the  $f_{MAX}$  column, while the recommended frequency (and  $R_T$  value) for optimal efficiency over the given input condition is given in the  $f_{OPTIMAL}$  column. There are additional conditions that must be satisfied if the synchronization function is used. Please refer to the Synchronization section for details.

### Capacitor Selection Considerations

The  $C_{IN}$  and  $C_{OUT}$  capacitor values in Table 1 are the minimum recommended values for the associated operating conditions. Applying capacitor values below those indicated in Table 1 is not recommended, and may result in undesirable operation. Using larger values is generally acceptable, and can yield improved dynamic response, if necessary. Again, it is incumbent upon the user to verify proper operation over the intended system's line, load and environmental conditions.

Ceramic capacitors are small, robust and have very low ESR. However, not all ceramic capacitors are suitable. X5R and X7R types are stable over temperature, applied voltage and give dependable service. Other types, including Y5V and Z5U have very large temperature and voltage coefficients of capacitance. In an application circuit they may have only a small fraction of their nominal capacitance resulting in much higher output voltage ripple than expected.

Many of the output capacitances given in Table 1 specify an electrolytic capacitor. Ceramic capacitors may also be used in the application, but it may be necessary to use more of them. Many high value ceramic capacitors have a large voltage coefficient, so the actual capacitance of the component at the desired operating voltage may be only a fraction of the specified value. Also, the very low ESR of ceramic capacitors may necessitate additional capacitors for acceptable stability margin.

A final precaution regarding ceramic capacitors concerns the maximum input voltage rating of the LTM8052. A ceramic input capacitor combined with trace or cable inductance forms a high Q (under damped) tank circuit. If the LTM8052 circuit is plugged into a live supply, the

input voltage can ring to twice its nominal value, possibly exceeding the device's rating. This situation is easily avoided; see the Hot Plugging Safely section.

### Programming Switching Frequency

The LTM8052 has an operational switching frequency range between 100kHz and 1MHz. This frequency is programmed with an external resistor from the  $R_T$  pin to ground. Do not leave this pin open under any circumstance. See Table 2 for resistor values and the corresponding switching frequencies.

**Table 2.  $R_T$  Resistor Values and Their Resultant Switching Frequencies**

SWITCHING FREQUENCY (MHz)	$R_T$ (k $\Omega$ )
1	39.2
0.75	53.6
0.5	82.5
0.3	140
0.2	210
0.1	453

In addition, the Typical Performance Characteristics section contains a graph that shows the switching frequency versus  $R_T$  value.

### Switching Frequency Trade-Offs

It is recommended that the user apply the optimal  $R_T$  value given in Table 1 for the input and output operating condition. System level or other considerations, however, may necessitate another operating frequency. While the LTM8052 is flexible enough to accommodate a wide range of operating frequencies, a haphazardly chosen one may result in undesirable operation under certain operating or fault conditions. A frequency that is too high can reduce efficiency, generate excessive heat or even damage the LTM8052 in some fault conditions. A frequency that is too low can result in a final design that has too much output ripple or too large of an output capacitor.

### Switching Frequency Synchronization

The nominal switching frequency of the LTM8052 is determined by the resistor from the  $R_T$  pin to GND and may be set from 100kHz to 1MHz. The internal oscillator may also be synchronized to an external clock through the SYNC pin. The external clock applied to the SYNC pin

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must have a logic low below 0.6V, a logic high greater than 1.2V and frequency between 100kHz and 1MHz. The input frequency must be 20% higher than the frequency determined by the resistor at the RT pin. Input signals outside of these specified parameters may cause erratic switching behavior and subharmonic oscillations. The SYNC pin must be tied to GND if synchronization to an external clock is not required. When SYNC is grounded, the switching frequency is determined by the resistor at the RT pin.

### Switching Mode

The LTM8052 operates in forced continuous mode. This means that the part will not skip cycles when the load approaches zero amps. This may be particularly useful in applications where the synchronization function is used, or any time discontinuous switching is undesirable. The LTM8052 will not operate in forced continuous mode when an input UVLO, output OVLO or minimum duty cycle violation occurs.

### Soft-Start

The soft-start function controls the slew rate of the power supply output voltage during start-up. A controlled output voltage ramp minimizes output voltage overshoot, reduces inrush current from the  $V_{IN}$  supply, and facilitates supply sequencing. A capacitor connected from the SS pin to GND programs the slew rate. The capacitor is charged from an internal 11  $\mu$ A current source to produce a ramped output voltage.

### Maximum Output Current Adjust

To adjust the regulated load current, an analog voltage is applied to the CTL\_I pin or CTL\_T pins. Varying the voltage between 0V and 1.5V adjusts the maximum current between the minimum and the maximum current, typically 5.6A positive and 7.7A negative. Graphs of the output current vs CTL\_I and CTL\_T voltages are given in the Typical Performance Characteristics section. The LTM8052 provides a 2V reference voltage for conveniently applying resistive dividers to set the current limit. The

current limit can be set as shown in Figure 1 with the following equation:

$$I_{MAX} = \frac{7.467 \cdot R2}{R1 + R2} \text{ Amps (Positive Current)}$$

$$I_{MAX} = -\left(\frac{7.467 \cdot R2}{R1 + R2} + 2.1\right) \text{ Amps (Negative Current)}$$

### Load Current Derating Using the CTL\_T Pin

In high current applications, derating the maximum current based on operating temperature may prevent damage to the load. In addition, many applications have thermal limitations that will require the regulated current to be reduced based on the load and/or board temperature. To achieve this, the LTM8052 uses the CTL\_T pin to reduce the effective regulated current in the load. While CTL\_I programs the regulated current in the load, CTL\_T can be configured to reduce this regulated current based on the analog voltage at the CTL\_T pin. The load/board temperature derating is programmed using a resistor network with a temperature dependant resistance (Figure 2). When the board/load temperature rises, the CTL\_T voltage will decrease. To reduce the regulated current, the CTL\_T voltage must be lower than the voltage at the CTL\_I pin.  $V_{CTL\_T}$  may be higher than  $V_{CTL\_I}$ , but then it will have no effect.

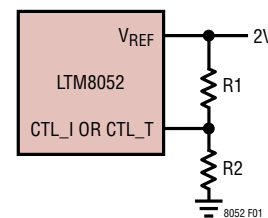


Figure 1. Setting the Output Current Limit

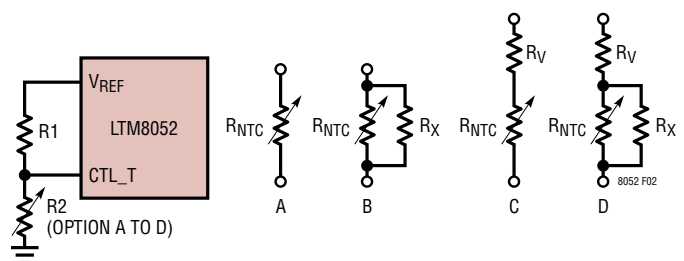


Figure 2. Load Current Derating vs Temperature Using NTC Resistor

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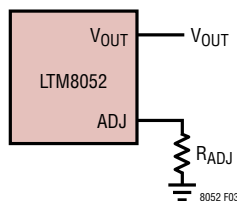
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### Voltage Regulation and Output Overvoltage Protection

The LTM8052 uses the ADJ pin to regulate the output voltage and to provide a high speed overvoltage lockout to avoid high voltage conditions. If the output voltage exceeds 125% of the regulated voltage level (1.5V at the ADJ pin), the LTM8052 terminates switching and shuts down switching for a brief time before restarting. The regulated output voltage must be greater than 1.19V and is set by the equation:

$$V_{OUT} = 1.19V \left( 1 + \frac{10k}{R_{ADJ}} \right)$$

where  $R_{ADJ}$  is shown in Figure 3.



**Figure 3. Voltage Regulation and Overvoltage Protection Feedback Connections**

In situations where the output of the LTM8052 is required to sink current (that is, the load is driving current into the LTM8052 output), the  $\mu$ Module regulator will maintain voltage regulation as long as the negative current limit is not exceeded. If the current limit is exceeded, the output voltage may begin to rise. If the output voltage rises more than 125% of the target regulation voltage, the output overvoltage protection will engage, and the LTM8052 will stop switching. In this situation, the load will be free to pull up the LTM8052 output. If the voltage exceeds the LTM8052 input, an internal power diode will clamp the output to a diode drop above the input.

### Thermal Shutdown

If the part is too hot, the LTM8052 engages its thermal shutdown, terminates switching and discharges the soft-start capacitor. When the part has cooled, the part automatically restarts. This thermal shutdown is set to engage at temperatures above the 125°C absolute maximum internal operating rating to ensure that it does not interfere with

functionality in the specified operating range. This means that internal temperatures will exceed the 125°C absolute maximum rating when the overtemperature protection is active, possibly impairing the device's reliability.

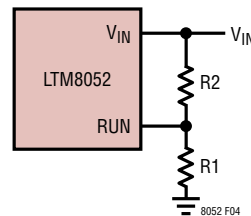
### UVLO and Shutdown

The LTM8052 has an internal UVLO that terminates switching, resets all logic, and discharges the soft-start capacitor when the input voltage is below 6V. The LTM8052 also has a precision RUN function that enables switching when the voltage at the RUN pin rises to 1.68V and shuts down the LTM8052 when the RUN pin voltage falls to 1.55V. There is also an internal current source that provides 5.5 $\mu$ A of pull-down current to program additional UVLO hysteresis. For RUN rising, the current source is sinking 5.5 $\mu$ A until RUN = 1.68V, after which the current source turns off. For RUN falling, the current source is off until the RUN = 1.55V, after which it sinks 5.5 $\mu$ A. The following equations determine the voltage divider resistors for programming the falling UVLO voltage and rising enable voltage ( $V_{ENA}$ ) as configured in Figure 4.

$$R1 = \frac{1.55V \cdot R2}{UVLO - 1.55V}$$

$$R2 = \frac{V_{ENA} - 1.084 \cdot UVLO}{5.5\mu A}$$

The RUN pin has an absolute maximum voltage of 6V. To accommodate the largest range of applications, there is an internal Zener diode that clamps this pin, so that it can be pulled up to a voltage higher than 6V through a resistor that limits the current to less than 100 $\mu$ A. For applications where the supply range is greater than 4:1, size R2 greater than 375k.



**Figure 4. UVLO Configuration**



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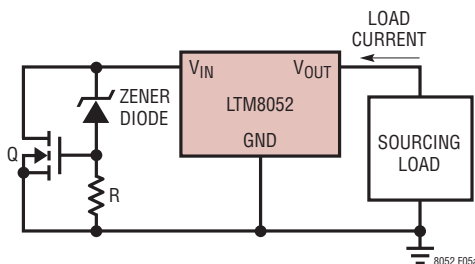
### Input Precautions

When the LTM8052 is sinking current, it maintains its output voltage regulation by power conversion, not power dissipation. This means that the energy provided to the LTM8052 is in turn delivered to its input power bus. There must be something on this power bus to accept or use the energy, or the LTM8052's input voltage will rise. Left unchecked, the energy can raise the input voltage above the absolute maximum voltage rating and damage the LTM8052.

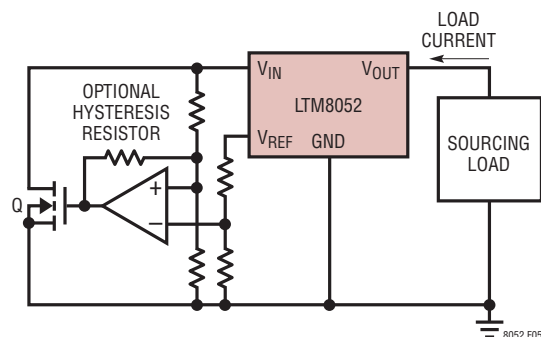
In many cases, the system load on the LTM8052 input bus will be sufficient to absorb the energy delivered by the  $\mu$ Module regulator. The power required by other devices will consume more than enough to make up for what the LTM8052 delivers. In cases where the LTM8052 is the largest or only power converter, this may not be true and some means may be needed to be devised to prevent the LTM8052's input from rising too high. Figure 5a shows a passive crowbar circuit that will dissipate energy during momentary input overvoltage conditions. The breakdown voltage of the zener diode is chosen in conjunction with the resistor R to set the circuit's trip point. The trip point is typically set well above the maximum  $V_{IN}$  voltage under normal operating conditions. This circuit does not have a precision threshold, and is subject to both part-to-part and temperature variations, so it is not suitable for applications where high accuracy is required or large voltage margins are not available.

The circuit in Figure 5b also dissipates energy during momentary overvoltage conditions, but is more precise than that in Figure 5a. It uses an inexpensive comparator and the  $V_{REF}$  output of the LTM8052 to establish a reference voltage. The optional hysteresis resistor in the comparator circuit avoids MOSFET chatter. Figure 5c shows a circuit that latches on and crowbars the input in an overvoltage event. The SCR latches when the input voltage threshold is exceeded, so this circuit should be used with a fuse, as shown, or employ some other method to interrupt current from the load.

As mentioned, the LTM8052 sinks current by energy conversion and not dissipation. Thus, no matter what protection circuit that is used, the amount of power that the protection circuit must absorb depends upon the amount of power at the input. For example, if the output voltage is 2.5V and can sink 5A, the input protection circuit should be designed to absorb at least 7.5W. In Figures 5a and 5b, let us say that the protection activation threshold is 30V. Then the circuit must be designed to be able to dissipate 7.5W and accept  $7.5W/30V = 250mA$ .



**Figure 5a. The MOSFET Q Dissipates Momentary Energy to GND. The Zener Diode and Resistor Are Chosen to Ensure That the MOSFET Turns On Above the Maximum  $V_{IN}$  Voltage Under Normal Operation**



**Figure 5b. The Comparator in This Circuit Activates the Q MOSFET at a More Precise Voltage Than the One Shown in Figure 5a. The Reference for the Comparator is Derived from the  $V_{REF}$  Pin of the LTM8052**

## APPLICATIONS INFORMATION

Figures 5a through 5c are crowbar circuits, which attempt to prevent the input voltage from rising above some level by clamping the input to GND through a power device. In some cases, it is possible to simply turn off the LTM8052 when the input voltage exceeds some threshold. This is possible when the voltage power source that drives current into  $V_{OUT}$  never exceeds  $V_{IN}$ . An example of this circuit is shown in Figure 5d. When the power source on the output drives  $V_{IN}$  above a predetermined threshold, the comparator pulls down on the RUN pin and stops switching in the LTM8052. When this happens, the input capacitance needs to absorb the energy stored within the LTM8052's internal inductor, resulting in an additional voltage rise. As shown in the Block Diagram, the internal inductor value is 2.2 $\mu$ H. If the LTM8052 negative current limit is set to 5A, for example, the energy that the input

capacitance must absorb is  $1/2 LI^2 = 27.5\mu\text{J}$ . Suppose the comparator circuit in Figure 5d is set to pull the RUN pin down when  $V_{TRIP} = 15\text{V}$ . The input voltage will rise according to the capacitor energy equation:

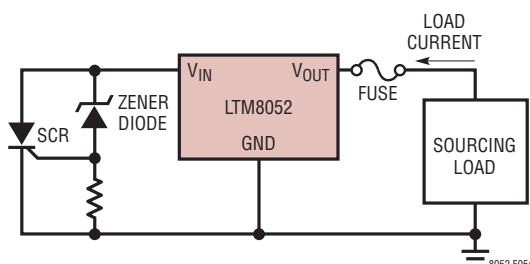
$$\frac{1}{2}C(V_{IN}^2 - V_{TRIP}^2) = 27.5\mu\text{J}$$

If the total input capacitance is 10 $\mu\text{F}$ , the input voltage will rise to:

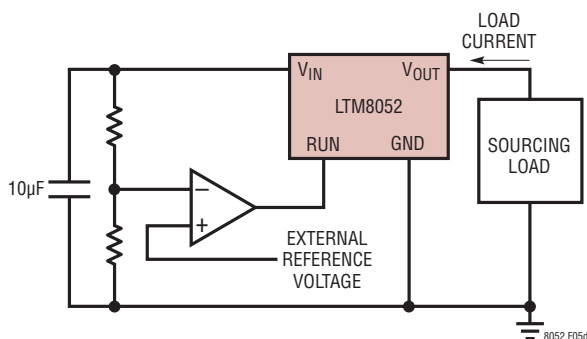
$$27.5\mu\text{J} = \frac{1}{2}10\mu\text{F}(V_{IN}^2 - 15\text{V}^2)$$

$$V_{IN} = 15.2\text{V}$$

For applications where only sourcing current (one quadrant operation) is desired, use LTM8026.



**Figure 5c. The SCR Latches On When the Activation Threshold is Reached, So a Fuse or Some Other Method of Disconnecting the Load Should be Used**



**Figure 5d. This Comparator Circuit Turns Off the LTM8052 if the Input Rises Above a Predetermined Threshold. When the LTM8052 Turns Off, the Energy Stored in the Internal Inductor Will Raise  $V_{IN}$  a Small Amount Above the Threshold.**

## APPLICATIONS INFORMATION

### No Output Current Sharing

The LTM8052 is a two quadrant device, able to both sink and source current to maintain voltage regulation. It is therefore not suitable for current sharing.

### PCB Layout

Most of the headaches associated with PCB layout have been alleviated or even eliminated by the high level of integration of the LTM8052. The LTM8052 is nevertheless a switching power supply, and care must be taken to minimize EMI and ensure proper operation. Even with the high level of integration, you may fail to achieve specified operation with a haphazard or poor layout. See Figure 6 for a suggested layout. Ensure that the grounding and heat sinking are acceptable.

A few rules to keep in mind are:

1. Place the  $R_{ADJ}$  and  $R_T$  resistors as close as possible to their respective pins.
2. Place the  $C_{IN}$  capacitor as close as possible to the  $V_{IN}$  and GND connection of the LTM8052.
3. Place the  $C_{OUT}$  capacitor as close as possible to the  $V_{OUT}$  and GND connection of the LTM8052.
4. Place the  $C_{IN}$  and  $C_{OUT}$  capacitors such that their ground currents flow directly adjacent or underneath the LTM8052.
5. Connect all of the GND connections to as large a copper pour or plane area as possible on the top layer. Avoid breaking the ground connection between the external components and the LTM8052.
6. Use vias to connect the GND copper area to the board's internal ground planes. Liberally distribute these GND vias to provide both a good ground connection and thermal path to the internal planes of the printed circuit board. Pay attention to the location and density of the thermal vias in Figure 6. The LTM8052 can benefit from the heat sinking afforded by vias that connect to internal GND planes at these locations, due to their proximity to internal power handling components. The optimum number of thermal vias depends upon the printed circuit board design. For example, a board might use very small via holes. It should employ more thermal vias than a board that uses larger holes.

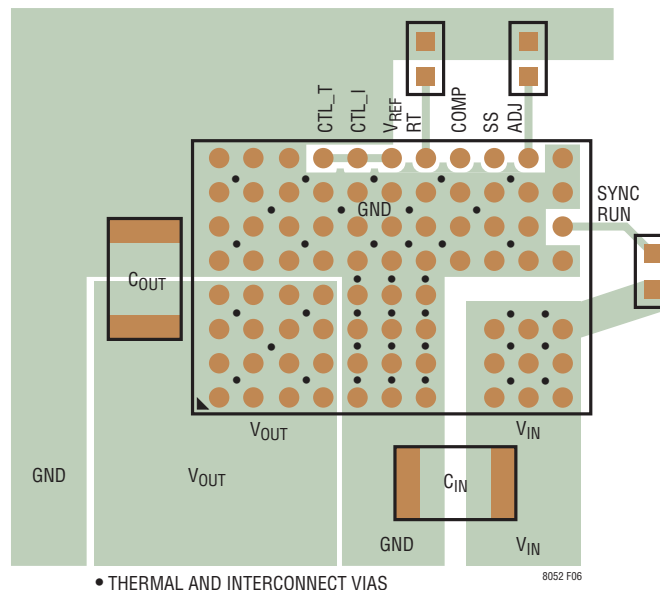


Figure 6. Layout Showing Suggested External Components, GND Plane and Thermal Vias.

## APPLICATIONS INFORMATION

### Hot Plugging Safely

The small size, robustness and low impedance of ceramic capacitors make them an attractive option for the input bypass capacitor of LTM8052. However, these capacitors can cause problems if the LTM8052 is plugged into a live input supply (see Application Note 88 for a complete discussion). The low loss ceramic capacitor combined with stray inductance in series with the power source forms an underdamped tank circuit, and the voltage at the  $V_{IN}$  pin of the LTM8052 can ring to more than twice the nominal input voltage, possibly exceeding the LTM8052's rating and damaging the part. If the input supply is poorly controlled or the user will be plugging the LTM8052 into an energized supply, the input network should be designed to prevent this overshoot. This can be accomplished by installing a small resistor in series to  $V_{IN}$ , but the most popular method of controlling input voltage overshoot is to add an electrolytic bulk capacitor to the  $V_{IN}$  net. This capacitor's relatively high equivalent series resistance damps the circuit and eliminates the voltage overshoot. The extra capacitor improves low frequency ripple filtering and can slightly improve the efficiency of the circuit, though it is physically large.

### Thermal Considerations

The LTM8052 output current may need to be derated if it is required to operate in a high ambient temperature. The amount of current derating is dependent upon the input voltage, output power and ambient temperature. The temperature rise curves given in the Typical Performance Characteristics section can be used as a guide. These curves were generated by the LTM8052 mounted to a 58cm<sup>2</sup> 4-layer FR4 printed circuit board. Boards of other sizes and layer count can exhibit different thermal behavior, so it is incumbent upon the user to verify proper operation over the intended system's line, load and environmental operating conditions.

For increased accuracy and fidelity to the actual application, many designers use finite element analysis (FEA) to predict thermal performance. To that end, Page 2 of the data sheet typically gives four thermal coefficients:

$\theta_{JA}$  – Thermal resistance from junction to ambient

$\theta_{JCbottom}$  – Thermal resistance from junction to the bottom of the product case

$\theta_{JCtop}$  – Thermal resistance from junction to top of the product case

$\theta_{JB}$  – Thermal resistance from junction to the printed circuit board.

While the meaning of each of these coefficients may seem to be intuitive, JEDEC has defined each to avoid confusion and inconsistency. These definitions are given in JESD 51-12, and are quoted or paraphrased below:

$\theta_{JA}$  is the natural convection junction-to-ambient air thermal resistance measured in a one cubic foot sealed enclosure. This environment is sometimes referred to as “still air” although natural convection causes the air to move. This value is determined with the part mounted to a JESD 51-9 defined test board, which does not reflect an actual application or viable operating condition.

$\theta_{JCbottom}$  is the junction-to-board thermal resistance with all of the component power dissipation flowing through the bottom of the package. In the typical  $\mu$ Module regulator, the bulk of the heat flows out the bottom of the package, but there is always heat flow out into the ambient environment. As a result, this thermal resistance value may be useful for comparing packages but the test conditions don't generally match the user's application.

$\theta_{JCtop}$  is determined with nearly all of the component power dissipation flowing through the top of the package. As the electrical connections of the typical  $\mu$ Module regulator are on the bottom of the package, it is rare for an application to operate such that most of the heat flows from the junction to the top of the part. As in the case of  $\theta_{JCbottom}$ , this value may be useful for comparing packages but the test conditions don't generally match the user's application.

## APPLICATIONS INFORMATION

$\theta_{JB}$  is the junction-to-board thermal resistance where almost all of the heat flows through the bottom of the  $\mu$ Module regulator and into the board, and is really the sum of the  $\theta_{JCbottom}$  and the thermal resistance of the bottom of the part through the solder joints and through a portion of the board. The board temperature is measured a specified distance from the package, using a 2-sided, 2-layer board. This board is described in JESD 51-9.

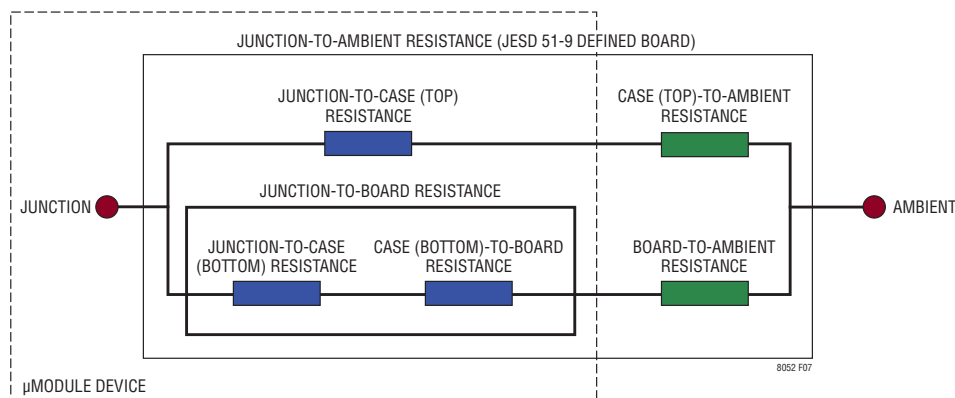
Given these definitions, it should now be apparent that none of these thermal coefficients reflects an actual physical operating condition of a  $\mu$ Module regulator. Thus, none of them can be individually used to accurately predict the thermal performance of the product. Likewise, it would be inappropriate to attempt to use any one coefficient to correlate to the junction temperature vs load graphs given in the product's data sheet. The only appropriate way to use the coefficients is when running a detailed thermal

analysis, such as FEA, which considers all of the thermal resistances simultaneously.

A graphical representation of these thermal resistances is given in Figure 7.

The blue resistances are contained within the  $\mu$ Module device, and the green are outside.

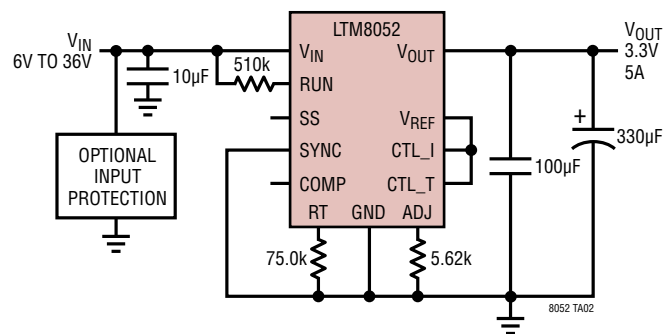
The die temperature of the LTM8052 must be lower than the maximum rating of 125°C, so care should be taken in the layout of the circuit to ensure good heat sinking of the LTM8052. The bulk of the heat flow out of the LTM8052 is through the bottom of the module and the LGA pads into the printed circuit board. Consequently a poor printed circuit board design can cause excessive heating, resulting in impaired performance or reliability. Please refer to the PCB Layout section for printed circuit board design suggestions.



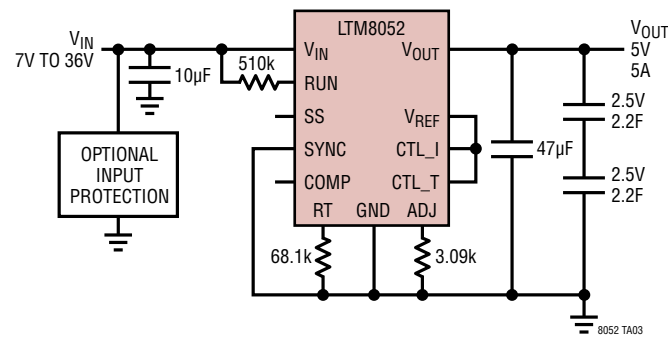
**Figure 7. Thermal Resistances Among  $\mu$ Module Device, Printed Circuit Board and Environment**

TYPICAL APPLICATIONS

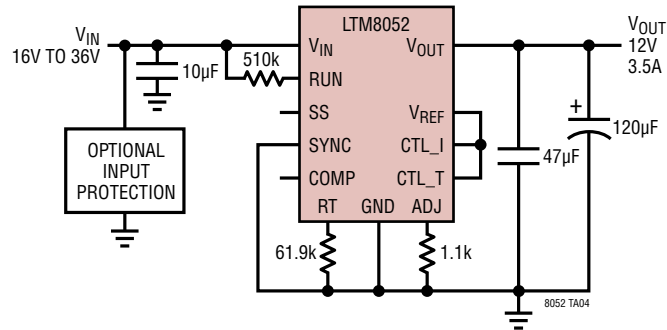
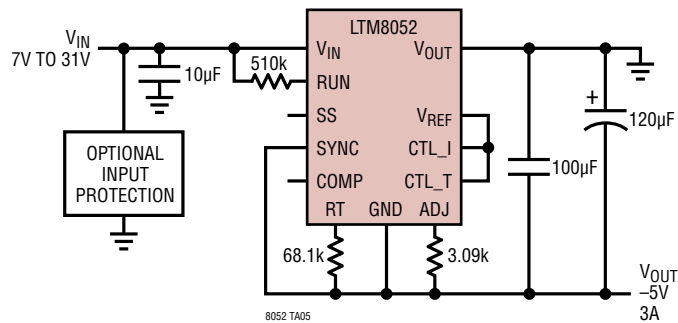
36V<sub>IN</sub>, 3.3V<sub>OUT</sub> Step-Down CVCC Converter



36V<sub>IN</sub>, LTM8052 Charges Two 2.5V Series Supercapacitors at 5.6A

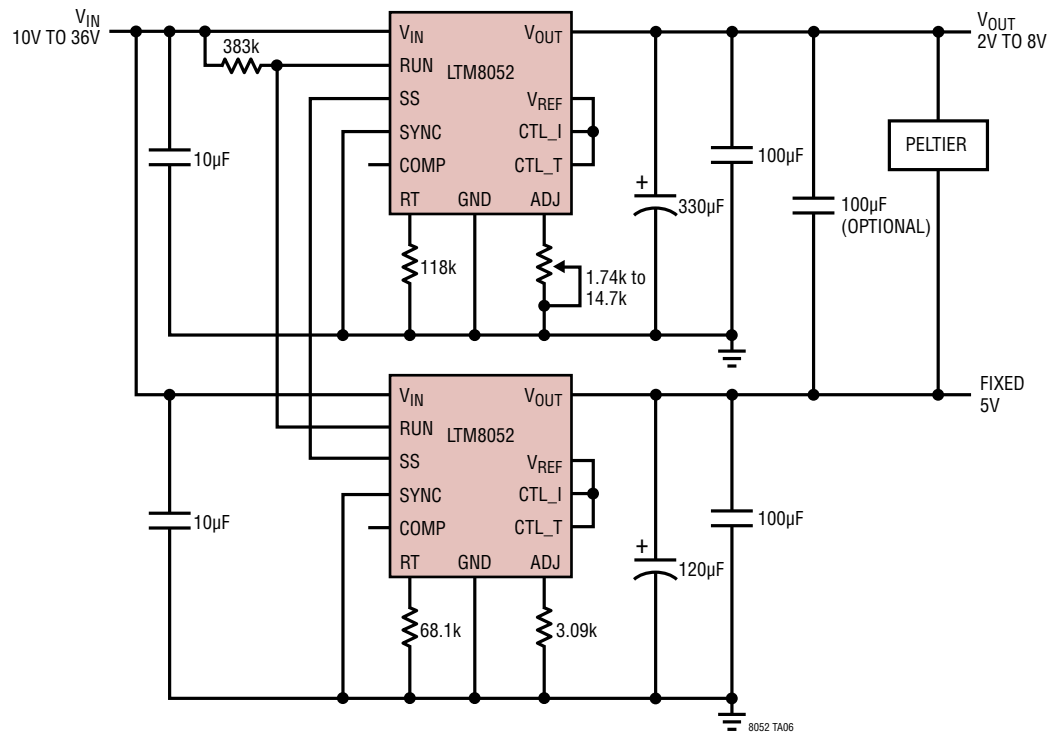


## TYPICAL APPLICATIONS

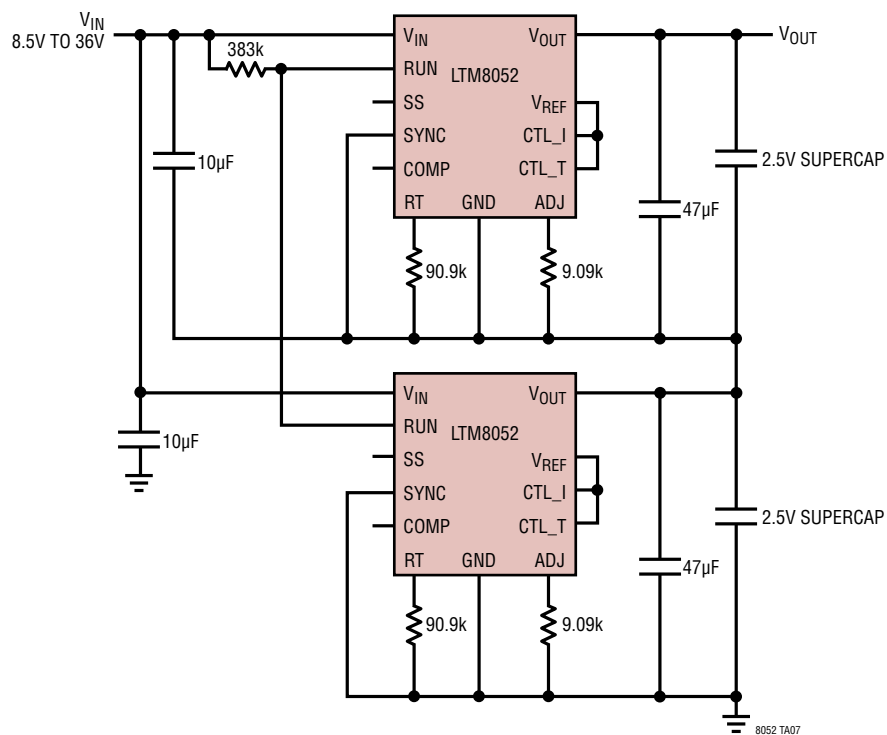
36V<sub>IN</sub>, 12V<sub>OUT</sub> Step-Down CVCC Converter36V<sub>IN</sub>, -5V<sub>OUT</sub> Negative CVCC Converter

TYPICAL APPLICATIONS

Two LTM8052s Used to Regulate Positive or Negative Voltage (and Current) Across a Peltier Device



Stack Two LTM8052s to Charge and Actively Balance Supercapacitors (or Batteries)

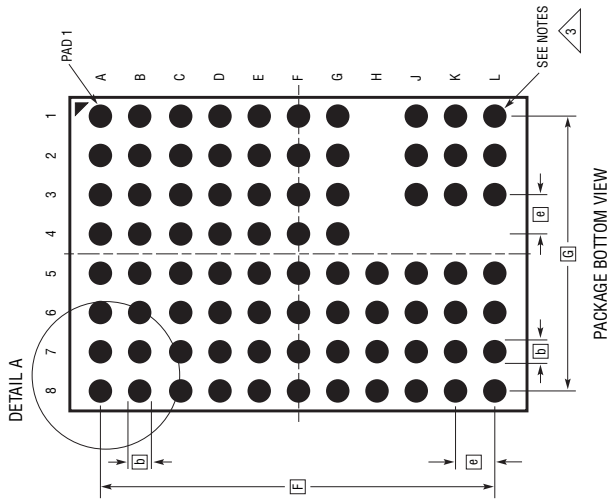




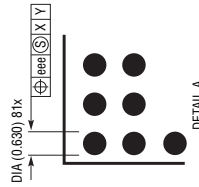
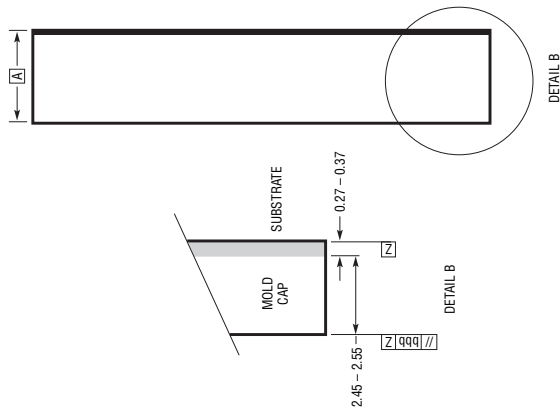
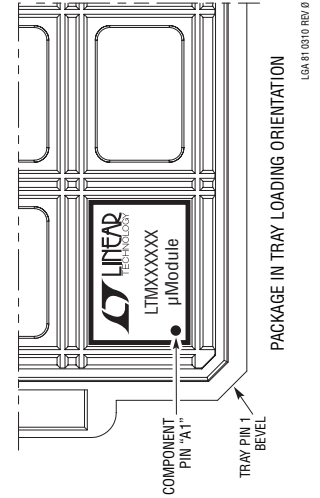
# PACKAGE DESCRIPTION

Please refer to <http://www.linear.com/designtools/packaging/> for the most recent package drawings.

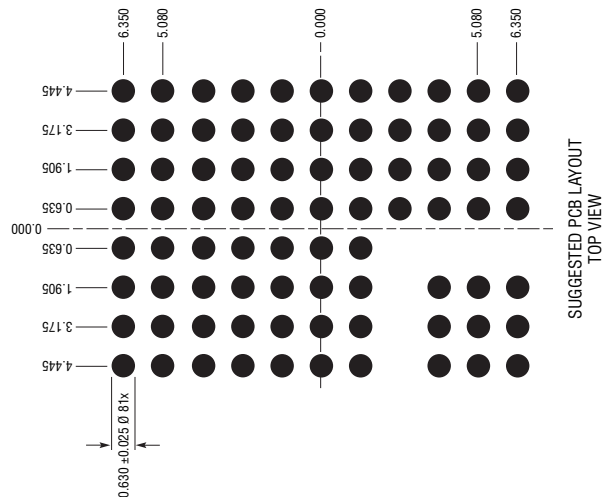
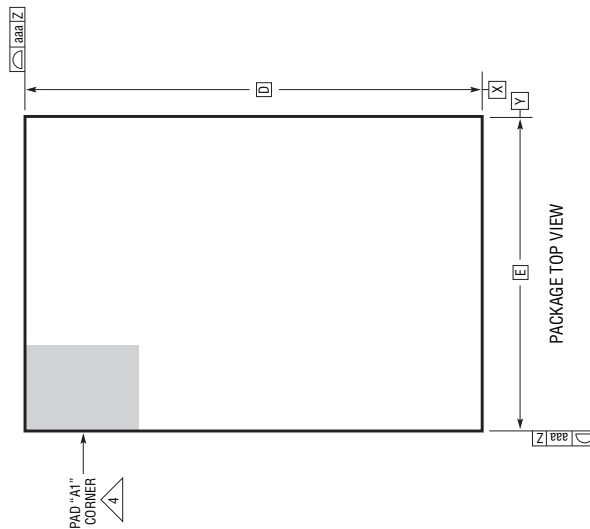
## LGA Package 81-Lead (15mm × 11.25mm × 2.82mm) (Reference LTC DWG # 05-08-1868 Rev 0)



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
  2. ALL DIMENSIONS ARE IN MILLIMETERS
  3. LAND DESIGNATION PER JEDEC MO-222, SPP-010
  4. DETAILS OF PAD #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE PAD #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE
  5. PRIMARY DATUM - Z - IS SEATING PLANE
  6. THE TOTAL NUMBER OF PADS: 81



DIMENSIONS				
SYMBOL	MIN	NOM	MAX	NOTES
A	2.72	2.82	2.92	
b	0.60	0.63	0.66	
D		15.0		
E		11.25		
e		1.27		
F		12.70		
G		8.89		
aaa			0.15	
bbb			0.10	
eee			0.05	
TOTAL NUMBER OF LGA PADS: 81				



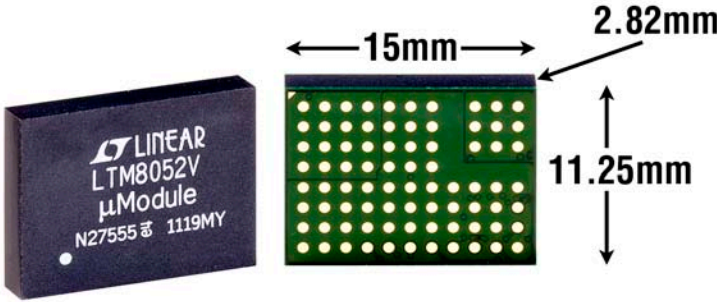
PACKAGE DESCRIPTION

Table 3. Pin Assignment Table (Arranged by Pin Number)

PIN ID	FUNCTION	PIN ID	FUNCTION	PIN ID	FUNCTION	PIN ID	FUNCTION	PIN ID	FUNCTION	PIN ID	FUNCTION
A1	V <sub>OUT</sub>	B1	V <sub>OUT</sub>	C1	V <sub>OUT</sub>	D1	V <sub>OUT</sub>	E1	GND	F1	GND
A2	V <sub>OUT</sub>	B2	V <sub>OUT</sub>	C2	V <sub>OUT</sub>	D2	V <sub>OUT</sub>	E2	GND	F2	GND
A3	V <sub>OUT</sub>	B3	V <sub>OUT</sub>	C3	V <sub>OUT</sub>	D3	V <sub>OUT</sub>	E3	GND	F3	GND
A4	V <sub>OUT</sub>	B4	V <sub>OUT</sub>	C4	V <sub>OUT</sub>	D4	V <sub>OUT</sub>	E4	GND	F4	GND
A5	GND	B5	GND	C5	GND	D5	GND	E5	GND	F5	GND
A6	GND	B6	GND	C6	GND	D6	GND	E6	GND	F6	GND
A7	GND	B7	GND	C7	GND	D7	GND	E7	GND	F7	GND
A8	GND	B8	GND	C8	GND	D8	CTL <sub>T</sub>	E8	CTL <sub>I</sub>	F8	V <sub>REF</sub>

PIN ID	FUNCTION	PIN ID	FUNCTION	PIN ID	FUNCTION	PIN ID	FUNCTION	PIN ID	FUNCTION
G1	GND	–	–	J1	V <sub>IN</sub>	K1	V <sub>IN</sub>	L1	V <sub>IN</sub>
G2	GND	–	–	J2	V <sub>IN</sub>	K2	V <sub>IN</sub>	L2	V <sub>IN</sub>
G3	GND	–	–	J3	V <sub>IN</sub>	K3	V <sub>IN</sub>	L3	V <sub>IN</sub>
G4	GND	–	–	–	–	–	–	–	–
G5	GND	H5	GND	J5	GND	K5	GND	L5	GND
G6	GND	H6	GND	J6	GND	K6	GND	L6	RUN
G7	GND	H7	GND	J7	GND	K7	GND	L7	SYNC
G8	RT	H8	COMP	J8	SS	K8	ADJ	L8	GND

PACKAGE PHOTO

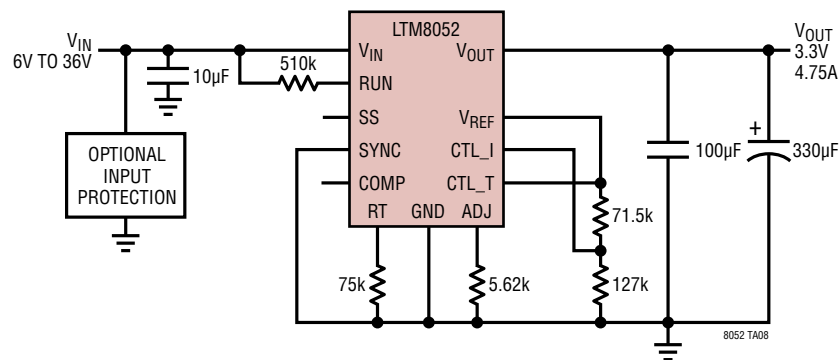


## REVISION HISTORY

REV	DATE	DESCRIPTION	PAGE NUMBER
A	3/12	Modified the Description section.	1
		Updated the Absolute Maximum Ratings and Pin Configuration sections.	2
		Corrected the pin name on schematics using two LTM8052s.	24
		Updated the Related Parts table.	28

TYPICAL APPLICATION

36VIN, 3.3VOUT Step-Down Converter with 4.75A Accurate Current Limit



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LTM8026	36VIN, 5A Step-Down µModule Regulator with Adjustable Current Limit	6V ≤ VIN ≤ 36V, 1.2V ≤ VOUT ≤ 24V, Adjustable Current Limit, Paralleleable Outputs, CLK Input, 11.25mm × 15mm × 2.82mm LGA Package
LTM8025	36VIN, 3A Step-Down µModule Regulator	3.6V ≤ VIN ≤ 36V, 0.8V ≤ VOUT ≤ 24V, CLK Input, 9mm × 15mm × 4.32mm LGA Package
LTM8062/ LTM8062A	32VIN, 2A µModule Battery Charger with Maximum Peak Power Tracking (MPPT)	Adjustable VBATT up to 14.4V (18.8V for the LTM8062A), C/10 or Timer Termination, 9mm × 15mm × 4.32mm LGA Package
LTM8027	60VIN, 4A DC/DC Step-Down µModule Regulator	4.5V ≤ VIN ≤ 60V, 2.5V ≤ VOUT ≤ 24V, 15mm × 15mm × 4.32mm LGA Package
LTM4613	EN55022B Compliant 36VIN, 8A Step-Down µModule Regulator	5V ≤ VIN ≤ 36V, 3.3V ≤ VOUT ≤ 15V, Synchronizable, Paralleleable, 15mm × 15mm × 4.32mm LGA Package